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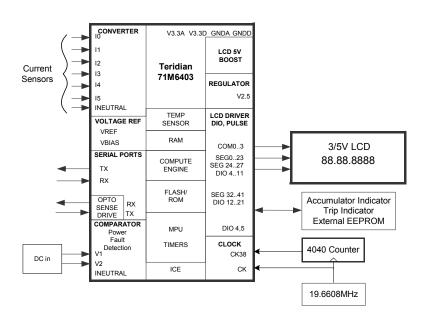
## GENERAL DESCRIPTION

The Teridian 71M6403 is an electronic trip unit (ETU) system-on-chip device for air circuit breakers (ACB), molded case circuit breakers (MCCB) and other types of intelligent switchgear. Utilizing Teridian's patented Single Converter Technology<sup>TM</sup>, the 71M6403 incorporates a 22-bit delta-sigma ADC, 7 current sensor inputs, digital temperature compensation, precision voltage reference, 32-bit programmable computation engine, timers, Real Time Clock (RTC), two UARTs and a single cycle execution 8-bit MCU.

Armed with an internal digital di/dt integrator, this programmable device supports either current transformer (CT) or Rogowski-Coils for any or all input channels and provides instantaneous and delayed over current, earth-leakage, ground-fault and arc fault protection functions. Furthermore, the device may be configured to support any number of conventional or custom protection algorithms that fit specific load configurations in the field.

The 71M6403 also includes a 5V LCD charge pump as well as 3V LCD support with up to 168 pixels display and up to 22 DIO pins. Easy conversion to ROM offers unprecedented cost structure for high volume MCCB applications.

A complete suite of in-circuit emulator (ICE) and development tools, a powerful real-time signal monitoring tool, programming libraries and reference designs enable rapid development of advanced switchgear.



## **FEATURES**

- 22-bit Sigma-delta converter
- Six main sensor inputs
- One auxiliary input
- Supports CT or Rogowski Coils
- Internal di/dt integrators
- < 5 msec. startup time</p>
- Better than 10ppm/°C accuracy
- Instantaneous and delay trip
- Peak & RMS current measurement
- Calculated or measured GND current
- Power measurement functions option
- Internal temperature sensor
- Digital temperature compensation
- Independent 32-bit compute engine
- Two UART ports
- Two timers
- Hardware watchdog
- Internal power fault detector
- Real Time Clock (RTC)
- Battery backup (RTC, RAM)
- 8-bit MPU (80515) 1 clock cycle per instruction (5 Mhz max.)
- LCD driver ( ≤168 pixels)
- 5V LCD charge pump
- Up to 22 general purpose I/O pins
- High speed serial interface (SSI)
- I<sup>2</sup>C EEPROM interface
- 64KB Flash, 7KB RAM
- Flash memory security
- 30mW @ 3.3V
- 100-lead LQFP package



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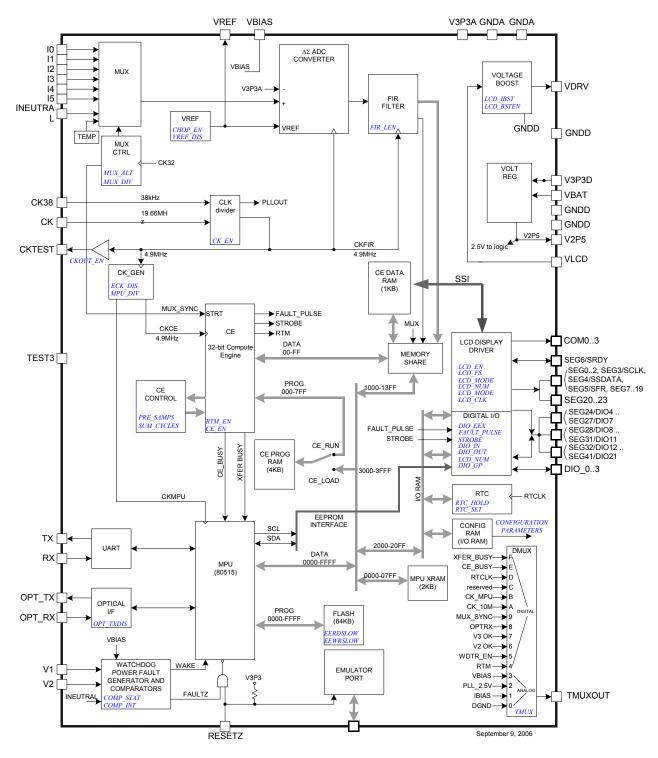


Figure 1: IC Functional Block Diagram



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## HARDWARE DESCRIPTION

## Hardware Overview

The TERIDIAN 71M6403 single chip Electronic Trip Unit integrates all primary functional blocks required to implement a solidstate circuit breaker. Included on chip are an analog front end (AFE), an 8051-compatible microprocessor (MPU) which executes one instruction per clock cycle (80515), an independent 32-bit digital computation engine (CE), a voltage reference, LCD drivers, RAM, FLASH memory, and a variety of I/O pins. Various current sensor technologies are supported including Current Transformers (CT), Resistive Shunts, and Rogowski (*di/dt*) Coils.

Measurements can be displayed on either a 3V or a 5V LCD. Flexible mapping of LCD display segments will facilitate integration with any LCD format. The design trade-off between the number of LCD segments and DIO pins can be flexibly configured using memory-mapped I/O to accommodate various requirements.

The 71M6403 includes several I/O peripheral functions that improve the functionality of the device and reduce the component count for most circuit breaker applications. The I/O peripherals include two UARTs, digital I/O, comparator inputs, LCD display drivers, I<sup>2</sup>C interface and an optical/IR interface.

One of the two internal UARTs (UART1) is adapted to support an Infrared LED with higher internal drive output and sense input. It can also be configured to function as a standard UART with normal digital IOs.

A block diagram of the chip is shown in Figure 1. A detailed description of various hardware blocks follows.

#### **External Components**

The 71M6403 is optimized for fast startup. To achieve this, an external 19.6608 MHz oscillator is required to drive CK, the primary clock input. The frequency for the CK38 input is generated from the 19.6608 MHz oscillator using an inexpensive 'HC4040 counter chip. The divide-by-512 output of the 'HC4040 generates a 38.4 kHz signal.

### Analog Front End (AFE)

The AFE of the TERIDIAN 71M6403 Electronic Trip Unit IC is comprised of an input multiplexer, a delta-sigma A/D converter with internal voltage reference, followed by an FIR filter. A block diagram of the AFE is shown in Figure 3.

### Multiplexer

The input multiplexer supports eight input signals that are applied to the pins I0 through I5, INEUTRAL plus the output of the internal temperature sensor. The multiplexer can be operated in two modes:

- During a normal multiplexer cycle, the signals from the six pins I0 through I5 are selected.
- During the alternate multiplexer cycle, the temperature signal (TEMP), INEUTRAL, and I1, I3, I4, I5 (*EQU* = 101) signal sources are selected. Use of the alternate multiplexer cycle is not recommended for fast response circuit breaker applications. Upon enabling the alternate multiplexer cycle, the I0 and I2 current samples are interrupted delaying over current trip detection response time.

| Regular multiplexer sequence<br>Mux State: |    |    |    |    | Alternate multiplexer sequence<br>Mux State: |      |    |          |    |    |    |
|--|----|----|----|----|--|------|----|----------|----|----|----|
| 0  | 1  | 2  | 3  | 4  | 5  | 0    | 1  | 2        | 3  | 4  | 5  |
| 10   | 11 | 12 | 13 | 14 | 15   | TEMP | 11 | INEUTRAL | 13 | 14 | 15 |

#### Table 1: Inputs Selected in Regular and Alternate Multiplexer Cycles (EQU = 101)

Note: Use of the alternate multiplexer cycle is not recommend.

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In a typical application, the I0 through I5 inputs are connected to current transformers or Rogowski coils that sense the current on each phase of the line voltage.

The Multiplexer Control Circuit handles the setting of the multiplexer. The function of the Multiplexer Control Circuit is governed by the I/O RAM registers *MUX\_ALT* (0x2005[2]) and *MUX\_DIV* (0x2002[7:6]). *MUX\_DIV* controls the number of samples per cycle. It can request 2, 3, 4, or 6 multiplexer states per cycle.

Multiplexer Control Circuit also controls the FIR filter initiation and the chopping of the ADC reference voltage, VREF. The Multiplexer Control Circuit is clocked by PLLOUT, the 32768Hz clock from the PLL block derived from CK, and launches each pass through the CE program.

### ADC

A single 21/22-bit delta-sigma A/D converter digitizes the power inputs to the AFE. The ADC inputs 10 - 15 are referenced to V3P3A with an input voltage range of  $\pm$  250 mv. The resolution of the ADC is programmable using the I/O RAM register *FIR\_LEN* register (0x2005[4]). ADC resolution may be selected to be 21 bits (*FIR\_LEN=*0), or 22 bits (*FIR\_LEN=*1). Conversion time is two cycles of PLLOUT with *FIR\_LEN* = 0 and three cycles with *FIR\_LEN* = 1.

Accuracy, timing and functional specifications in this data sheet are based on *FIR\_LEN* = 0 (two PLLOUT cycles).

Initiation of each ADC conversion is controlled by the Multiplexer Control Circuit as described previously.

### **FIR Filter**

The finite impulse response (FIR) filter is an integral part of the ADC and it is optimized for use with the multiplexer. The purpose of the FIR is to decimate the ADC output to the desired resolution. At the end of each ADC conversion, the output data of the FIR filter (raw data) is stored into the CE Data RAM (DRAM) location determined by the multiplexer selection. The location of the raw data in the CE DRAM is specified in the CE Program and Environment Section.

## Voltage Reference

The 71M6403 includes an on-chip precision bandgap voltage reference that incorporates auto-zero techniques. The reference of the 71M6403 is trimmed in production to minimize errors caused by component mismatch and drift. The result is a voltage output with a predictable temperature coefficient.

The voltage reference is chopper stabilized, i.e. the polarity can be switched by the MPU using the I/O RAM register *CHOP\_ENA* (0x2002[5:4]). The two bits in the *CHOP\_ENA* register enable the MPU to operate the chopper circuit in regular or inverted operation, or in "toggling" mode. When the chopper circuit is toggled in between multiplexer cycles, DC offsets on the measured signals will automatically be averaged out.



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The general topology of a chopped amplifier is given in Figure 2.

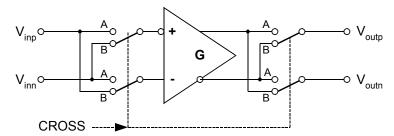


Figure 2: General Topology of a Chopped Amplifier

It is assumed that an offset voltage Voff appears at the positive amplifier input. With all switches, as controlled by CROSS in the "A" position, the output voltage is:

Voutp – Voutn = G (Vinp + Voff – Vinn) = G (Vinp – Vinn) + G Voff

With all switches set to the "B" position by applying the inverted CROSS signal, the output voltage is:

Voutn – Voutp = G (Vinn – Vinp + Voff) = G (Vinn – Vinp) + G Voff, or

Voutp - Voutn = G (Vinp - Vinn) - G Voff

Thus, when CROSS is toggled, e.g. after each multiplexer cycle, the offset will alternately appear on the output as positive and negative, which results in the offset effectively being eliminated, regardless of its polarity or magnitude.

The Functional Description Section contains a chapter with a detailed description on controlling the CHOP\_ENA register.

### **Temperature Sensor**

The 71M6403 includes an on-chip temperature sensor implemented as a bandgap reference. It is used to determine the die temperature. The MPU may request an alternate multiplexer cycle containing the temperature sensor output by asserting *MUX\_ALT*.

Reading the internal temperature sensor requires enabling the alternate multiplexer cycle. The alternate multiplexer cycle then displaces a normal I0-I5 current sensors acquisition cycle. Therefore, detection of an over current event may be delayed.

### INEUTRAL

INEUTRAL is an analog monitor input that can be used for additional analog measurements, such as neutral current. It is sampled when the multiplexer performs an alternate multiplexer cycle. The zero reference for the INEUTRAL input is VBIAS.

INEUTRAL is also routed into the comparator block where it is compared to VBIAS. External interrupt 2 should be disabled when the INEUTRAL input is used for analog measurements.



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## **Functional Description**

The AFE functions as a data acquisition system, controlled by the MPU. The main signals (I0, I3, I1, I4, I2, I5) are sampled and the ADC counts obtained are stored in CE RAM where they can be accessed by the CE and, if necessary, by the MPU.

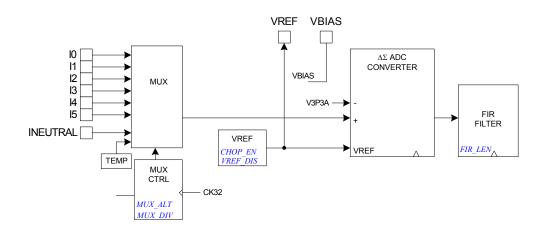


Figure 3: AFE Block Diagram

## **Computation Engine (CE)**

The CE, a dedicated 32-bit RISC processor, performs the precision computations necessary to accurately measure currents. The CE calculations and processes include:

• Scaling of the processed samples based on chip temperature (temperature compensation) and calibration coefficients.

The CE program RAM (CE PRAM) is loaded at boot time by the MPU and then executed by the CE. Each CE instruction word is 2 bytes long. The CE program counter begins a pass through the CE code each time multiplexer state 0 begins. The code pass ends when a HALT instruction is executed. For proper operation, the code pass must be completed before the multiplexer cycle ends (see System Timing Summary in the Functional Description Section).

The CE data RAM (CE DRAM) is shared by the FIR filter block, the RTM circuit, the CE, and the MPU. Assigned time slots are reserved for FIR, RTM, and MPU, respectively, such that memory accesses to CE\_RAM do not collide. Holding registers are used to convert 8-bit wide MPU data to/from 32-bit wide CE DRAM data, and wait states are inserted as needed, depending on the frequency of CKMPU.

Table 2 shows the CE DRAM addresses allocated to analog inputs from the AFE.



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| Address | Name         | Zero<br>Reference | Description         |  |
|---------|--------------|-------------------|---------------------|--|
| 0x00    | 10           | V3P3              | Current input 0     |  |
| 0x01    | l1           | V3P3              | Current input 1     |  |
| 0x02    | 02 I2 V3P3   |                   | Current input 2     |  |
| 0x03    | 03 I3 V3P3   |                   | Current input 3     |  |
| 0x04    | 0x04 I4 V3P3 |                   | Current input 4     |  |
| 0x05    | 0x05 I5 V3P3 |                   | Current input 5     |  |
| 0x06    | TEMP         |                   | Temperature         |  |
| 0x07    | INEUTRAL     | VBIAS             | INEUTRAL<br>monitor |  |

Table 2: CE DRAM Locations for ADC Results

## **CE Functional Overview**

The ADC processes one sample per channel per multiplexer cycle. Figure 4 shows the timing of the six samples taken during one multiplexer cycle.

The ADC sampling process and resultant accumulation interval calculations are described in the CE Program section.

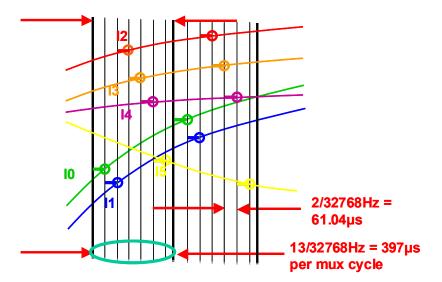


Figure 4: Samples in Multiplexer Cycle



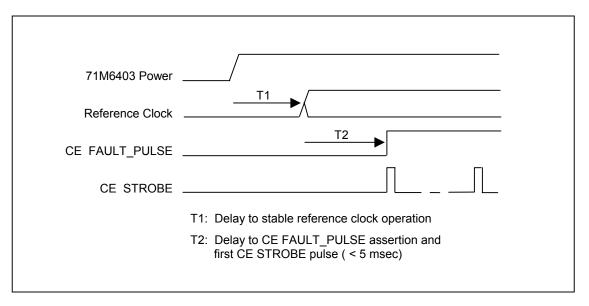
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## **Real-Time Monitor**

The CE contains a Real Time Monitor (RTM), which can be programmed to monitor four selectable CE RAM locations at full sample rate. The four monitored locations are serially output to the TMUXOUT pin via the digital output multiplexer at the beginning of each CE code pass (see the Test Ports Section for details)

## Power Up Short Circuit Detection Time

The 71M6403 detects a short circuit condition within less than 5 msec. (T2) after application of its power and a stable reference clock. This delay includes the firmware startup time for both the CE and the MPU, and for the CE to complete its initial measurements. The following diagram shows the timing delay of a CE trip indication relative to application of power and the reference clock.



#### **Power Up Detection Time**

The T1 delay is a system parameter dependent on the system clock architecture. T1 could be the start up time for an external oscillator powered from the same power source as the 71M6403, or T1 could be the delay from a system wide reference clock. If the reference clock is already stable prior to application of power to the 71M6403 (using a system wide reference clock), the T1 delay is eliminated. The resultant start up delay reduces to T2 assuming a "clean" application of power to the 71M6403.



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#### 80515 MPU Core

#### 80515 Overview

The 71M6403 includes an 80515 MPU (8-bit, 8051-compatible) that processes most instructions in one clock cycle. Using a 5MHz clock results in a processing throughput of 5 MIPS. The 80515 architecture eliminates redundant bus states and implements parallel execution of fetch and execution phases. Normally a machine cycle is aligned with a memory fetch, therefore, most of the 1-byte instructions are performed in a single cycle. This leads to an 8x performance (in average) improvement (in terms of MIPS) over the Intel 8051 device running at the same clock frequency.

Actual processor clocking speed can be adjusted to the total processing demand of the application (current and trip calculations, memory management, LCD driver management and I/O management) using the I/O RAM register MPU\_DIV[2:0].

Typical measurement and circuit breaker functions based on the internal 32-bit compute engine (CE) results are available for the MPU as part of TERIDIAN's standard library. A standard ANSI "C" 80515-application programming interface library is available to help reduce design cycle time.

#### Memory Organization

The 80515 MPU core incorporates the Harvard architecture with separate code and data spaces.

Memory organization in the 80515 is similar to that of the industry standard 8051. There are three memory areas: Program memory (Flash), external data memory (physically consisting of XRAM, CE Data RAM, CE Program RAM and I/O RAM), and internal data memory (Internal RAM). Figure 5 shows the memory map (see also Table 54).

**Internal and External Data Memory:** Both internal and external data memory are physically located in the 71M6403 IC. External data memory is only meant to imply external to the 80515 MPU core.

| 0xFFFF |              | 0xFFFF       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|--------|--------------|--------------|-------------|----------------------|--|--|--|--|--|--|--|--|--|--|--|--------|--|--|
|        |              | 0x4000       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x3FFF       | CE PRAM     |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x3000       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x2FFF       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x2100       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x20FF       | I/O RAM     |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        | Flash memory | Flash memory | 0x2000      |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x1FFF       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              |              |             |                      |  |  |  |  |  |  |  |  |  |  |  | 0x1400 |  |  |
|        |              | 0x13FF       | CE DRAM     |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x1000       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x0FFF       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x0800       |             |                      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
|        |              | 0x07FF       | XRAM        | 0xFF SFRs, RAM,      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
| 0x0000 |              | 0x0000       |             | 0x00 reg. banks      |  |  |  |  |  |  |  |  |  |  |  |        |  |  |
| Progra | am memory    | External     | data memory | Internal data memory |  |  |  |  |  |  |  |  |  |  |  |        |  |  |

#### Figure 5: Memory Map

**Program Memory:** The 80515 can address up to 64KB of program memory space from 0x0000 to 0xFFFF. Program memory is read when the MPU fetches instructions or performs a MOVC operation.

After reset, the MPU starts program execution from location 0x0000. The lower part of the program memory includes reset and interrupt vectors. The interrupt vectors are spaced at 8-byte intervals, starting from 0x0003.



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**External Data Memory:** While the 80515 can address up to 64KB of external data memory in the space from 0x0000 to 0xFFFF, only the memory ranges shown in Figure 5 contain physical memory. The 80515 writes into external data memory when the MPU executes a MOVX @Ri,A or MOVX @DPTR,A instruction. The MPU reads external data memory by executing a MOVX A,@Ri or MOVX A,@DPTR instruction (SFR USR2 provides the upper 8 bytes for the MOVX A,@Ri instruction).

**Clock Stretching:** MOVX instructions can access fast or slow external RAM and external peripherals. The three low ordered bits of the CKCON register define the stretch memory cycles. Setting all the *CKCON* stretch bits to one allows access to very slow external RAM or external peripherals.

Table 3 shows how the signals of the External Memory Interface change when stretch values are set from 0 to 7. The widths of the signals are counted in MPU clock cycles. The post-reset state (001) of the CKCON register, which is in **bold** in the table, performs the MOVX instructions with a stretch value equal to 1.

| CKCON register |         |         | Stretch Value | Read signals width |       | Write signal width |       |
|----------------|---------|---------|---------------|--------------------|-------|--------------------|-------|
| CKCON.2        | CKCON.1 | CKCON.0 |               | memaddr            | memrd | memaddr            | memwr |
| 0              | 0       | 0       | 0             | 1                  | 1     | 2                  | 1     |
| 0              | 0       | 1       | 1             | 2                  | 2     | 3                  | 1     |
| 0              | 1       | 0       | 2             | 3                  | 3     | 4                  | 2     |
| 0              | 1       | 1       | 3             | 4                  | 4     | 5                  | 3     |
| 1              | 0       | 0       | 4             | 5                  | 5     | 6                  | 4     |
| 1              | 0       | 1       | 5             | 6                  | 6     | 7                  | 5     |
| 1              | 1       | 0       | 6             | 7                  | 7     | 8                  | 6     |
| 1              | 1       | 1       | 7             | 8                  | 8     | 9                  | 7     |

 Table 3: Stretch Memory Cycle Width

**Direct vs Paged Addressing:** There are two types of instructions, differing in whether they provide an eight-bit or sixteen-bit indirect address to the external data RAM.

In the first type (MOVX A,@Ri), the contents of R0 or R1, in the current register bank, provide the eight lower-ordered bits of address. The eight high-ordered bits of address are specified with the USR2 SFR. This method allows the user paged access (256 pages of 256 bytes each) to the full 64KB of external data RAM. In the second type of MOVX instruction (MOVX A,@DPTR), the data pointer generates a sixteen-bit address. This form is faster and more efficient when accessing very large data arrays (up to 64 Kbytes), since no additional instructions are needed to set up the eight high ordered bits of address.

It is possible to mix the two MOVX types. This provides the user with four separate data pointers, two with direct access and two with paged access to the entire 64KB of external memory range.

**Dual Data Pointer:** The Dual Data Pointer accelerates the block moves of data. The standard DPTR is a 16-bit register that is used to address external memory or peripherals. In the 80515 core, the standard data pointer is called DPTR, the second data pointer is called DPTR1. The data pointer select bit chooses the active pointer. The data pointer select bit is located at the LSB of the DPS register (DPS.0). DPTR is selected when DPS.0 = 0 and DPTR1 is selected when DPS.0 = 1.

The user switches between pointers by toggling the LSB of the DPS register. All DPTR-related instructions use the currently selected DPTR for any activity.

#### The second data pointer may not be supported by certain compilers.



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**Internal Data Memory:** The Internal data memory provides 256 bytes (0x00 to 0xFF) of data memory. The internal data memory address is always 1 byte wide and can be accessed by either direct or indirect addressing. The Special Function Registers occupy the upper 128 bytes. This SFR area is available only by direct addressing. Indirect addressing accesses the upper 128 bytes of Internal RAM.

The lower 128 bytes contain working registers and bit-addressable memory. The lower 32 bytes form four banks of eight registers (R0-R7). Two bits on the program memory status word (PSW) select which bank is in use. The next 16 bytes form a block of bit-addressable memory space at bit addressees 0x00-0x7F. All of the bytes in the lower 128 bytes are accessible through direct or indirect addressing. Table 4 shows the internal data memory map.

| Address | Direct addressing          | Indirect addressing |  |  |  |
|---------|----------------------------|---------------------|--|--|--|
| 0xFF    | Special Function Registers | RAM                 |  |  |  |
| 0x80    | (SFRs)                     | KAM                 |  |  |  |
| 0x7F    | Buto add                   | Idressable area     |  |  |  |
| 0x30    | Byle-aut                   |                     |  |  |  |
| 0x2F    | Bit add                    |                     |  |  |  |
| 0x20    | Bit-audi                   |                     |  |  |  |
| 0x1F    | Devister backs D0 D7       |                     |  |  |  |
| 0x00    | Register                   | banks R0…R7         |  |  |  |

#### Table 4: Internal Data Memory Map

### Special Function Registers (SFRs)

A map of the Special Function Registers is shown in Table 5.

| Hex\Bin    | X000    | X001  | X010    | X011   | X100  | X101   | X110   | X111   | Bin/Hex |
|------------|---------|-------|---------|--------|-------|--------|--------|--------|---------|
| F8         | INTBITS |       |         |        |       |        |        |        | FF      |
| F0         | В       |       |         |        |       |        |        |        | F7      |
| E8         | WDI     |       |         |        |       |        |        |        | EF      |
| E0         | А       |       |         |        |       |        |        |        | E7      |
| D8         | WDCON   |       |         |        |       |        |        |        | DF      |
| D0         | PSW     |       |         |        |       |        |        |        | D7      |
| C8         |         |       |         |        |       |        |        |        | CF      |
| C0         | IRCON   |       |         |        |       |        |        |        | C7      |
| B8         | IEN1    | IP1   | SORELH  | S1RELH |       |        |        | USR2   | BF      |
| B0         |         |       | FLSHCTL |        |       |        |        | PGADR  | B7      |
| <b>A</b> 8 | IEN0    | IP0   | SORELL  |        |       |        |        |        | AF      |
| A0         | P2      | DIR2  | DIR0    |        |       |        |        |        | A7      |
| 98         | SOCON   | S0BUF | IEN2    | S1CON  | S1BUF | S1RELL | EEDATA | EECTRL | 9F      |
| 90         | P1      | DIR1  | DPS     |        | ERASE |        |        |        | 97      |
| 88         | TCON    | TMOD  | TLO     | TL1    | TH0   | TH1    | CKCON  |        | 8F      |
| 80         | P0      | SP    | DPL     | DPH    | DPL1  | DPH1   | WDTREL | PCON   | 87      |

### Table 5: Special Function Registers Locations

Only a few addresses are occupied, the others are not implemented. SFRs specific to the 71M6403 are shown in **bold** print. Any read access to unimplemented addresses will return undefined data, while any write access will have no effect.



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## Special Function Registers (Generic 80515 SFRs)

Table 6 shows the location of the SFRs and the value they assume at reset or power-up.

| Name   | Location | Reset value | Description  |  |
|--------|----------|-------------|--|--|
| P0     | 0x80     | 0xFF        | Port 0   |  |
| SP     | 0x81     | 0x07        | Stack Pointer                                      |  |
| DPL    | 0x82     | 0x00        | Data Pointer Low 0                                 |  |
| DPH    | 0x83     | 0x00        | Data Pointer High 0                                |  |
| DPL1   | 0x84     | 0x00        | Data Pointer Low 1                                 |  |
| DPH1   | 0x85     | 0x00        | Data Pointer High 1                                |  |
| WDTREL | 0x86     | 0x00        | Watchdog Timer Reload register                     |  |
| PCON   | 0x87     | 0x00        | UART Speed Control                                 |  |
| TCON   | 0x88     | 0x00        | Timer/Counter Control                              |  |
| TMOD   | 0x89     | 0x00        | Timer Mode Control                                 |  |
| TL0    | 0x8A     | 0x00        | Timer 0, low byte                                  |  |
| TL1    | 0x8B     | 0x00        | Timer 1, high byte                                 |  |
| TH0    | 0x8C     | 0x00        | Timer 0, low byte                                  |  |
| TH1    | 0x8D     | 0x00        | Timer 1, high byte                                 |  |
| CKCON  | 0x8E     | 0x01        | Clock Control (Stretch=1)                          |  |
| P1     | 0x90     | 0xFF        | Port 1   |  |
| DPS    | 0x92     | 0x00        | Data Pointer select Register                       |  |
| SOCON  | 0x98     | 0x00        | Serial Port 0, Control Register                    |  |
| SOBUF  | 0x99     | 0x00        | Serial Port 0, Data Buffer                         |  |
| IEN2   | 0x9A     | 0x00        | Interrupt Enable Register 2                        |  |
| S1CON  | 0x9B     | 0x00        | Serial Port 1, Control Register                    |  |
| S1BUF  | 0x9C     | 0x00        | Serial Port 1, Data Buffer                         |  |
| S1RELL | 0x9D     | 0x00        | Serial Port 1, Reload Register, low byte           |  |
| P2     | 0xA0     | 0x00        | Port 2   |  |
| IEN0   | 0xA8     | 0x00        | Interrupt Enable Register 0                        |  |
| IP0    | 0xA9     | 0x00        | Interrupt Priority Register 0                      |  |
| SORELL | 0xAA     | 0xD9        | Serial Port 0, Reload Register, low byte           |  |
| P3     | 0xB0     | 0xFF        | Port 3   |  |
| IEN1   | 0xB8     | 0x00        | Interrupt Enable Register 1                        |  |
| IP1    | 0xB9     | 0x00        | Interrupt Priority Register 1                      |  |
| SORELH | 0xBA     | 0x03        | Serial Port 0, Reload Register, high byte          |  |
| S1RELH | 0xBB     | 0x03        | Serial Port 1, Reload Register, high byte          |  |
| USR2   | 0xBF     | 0x00        | User 2 Port, high address byte for MOVX@Ri         |  |
| IRCON  | 0xC0     | 0x00        | Interrupt Request Control Register                 |  |
| PSW    | 0xD0     | 0x00        | Program Status Word                                |  |
| WDCON  | 0xD8     | 0x00        | Baud Rate Control Register (only WDCON.7 bit used) |  |
| А      | 0xE0     | 0x00        | Accumulator  |  |
| В      | 0xF0     | 0x00        | B Register   |  |

#### **Table 6: Special Function Registers Reset Values**

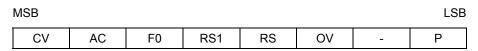


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Accumulator (ACC, A): ACC is the accumulator register. Most instructions use the accumulator to hold the operand. The mnemonics for accumulator-specific instructions refer to the accumulator as "A", not ACC.

**B Register:** The B register is used during multiply and divide instructions. It can also be used as a scratch-pad register to hold temporary data.

#### Program Status Word (PSW):



| т | abla | 7. | DCIV | Register | Flage |
|---|------|----|------|----------|-------|
|   | able | 1. | FOW  | register | гауэ  |

| Bit   | Symbol | Function | Function  |                  |                            |        |  |  |  |
|-------|--------|----------|---|------------------|----------------------------|--------|--|--|--|
| PSW.7 | CV     | Carry fl | Carry flag  |                  |                            |        |  |  |  |
| PSW.6 | AC     | Auxiliar | y Carry flag fo   | r BCD operations |                            |        |  |  |  |
| PSW.5 | F0     |          | Il purpose Flag<br>CE STATUS re   | •                | to be confused with the F0 | ) flag |  |  |  |
| PSW.4 | RS1    | •        | Register bank select control bits. The contents of RS1 and RS0 select the working register bank:                  |                  |                            |        |  |  |  |
|       |        |          | RS1/RS0   | Bank selected    | Location                   |        |  |  |  |
| PSW.3 | RS0    |          | 00  | Bank 0           | (0x00 – 0x07)              |        |  |  |  |
| P3W.3 | K30    |          | 01  | Bank 1           | (0x08 – 0x0F)              |        |  |  |  |
|       |        |          | 10  | Bank 2           | (0x10 – 0x17)              |        |  |  |  |
|       |        |          | 11  | Bank 3           | (0x18 – 0x1F)              |        |  |  |  |
| PSW.2 | OV     | Overflo  | Overflow flag   |                  |                            |        |  |  |  |
| PSW.1 | -      | User de  | User defined flag   |                  |                            |        |  |  |  |
| PSW.0 | Ρ      | -        | arity flag, affected by hardware to indicate odd / even number of "one" bits in the ccumulator, i.e. even parity. |                  |                            |        |  |  |  |

#### Table 8: PSW bit functions

**Stack Pointer (SP):** The stack pointer is a 1-byte register initialized to 0x07 after reset. This register is incremented before PUSH and CALL instructions, causing the stack to begin at location 0x08.

**Data Pointer:** The data pointer (DPTR) is 2 bytes wide. The lower part is DPL, and the highest is DPH. It can be loaded as a 2-byte register (MOV DPTR,#data16) or as two registers (e.g. MOV DPL,#data8). It is generally used to access external code or data space (e.g. MOVC A,@A+DPTR or MOVX A,@DPTR respectively).

**Program Counter:** The program counter (PC) is 2 bytes wide initialized to 0x0000 after reset. This register is incremented during the fetching operation code or when operating on data from program memory.



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**Port Registers:** The I/O ports are controlled by Special Function Registers *P0*, *P1*, and *P2*. The contents of the SFR can be observed on corresponding pins on the chip. Writing a '1' to any of the ports (see Table 9) causes the corresponding pin to be at high level (V3P3), and writing a '0' causes the corresponding pin to be held at low level (GND). The data direction registers *DIR0*, *DIR1*, and *DIR2* define individual pins as input or output pins (see the DIO section in On-Chip Resources for details.

| Register | SFR<br>Address | R/W | Description   |
|----------|----------------|-----|---|
| P0       | 0x80           | R/W | Register for port 0 read and write operations (pins DIO0DIO7)   |
| DIR0     | 0xA2           | R/W | Data direction register for port 0. Setting a bit to 1 means that the corresponding pin is an output. |
| P1       | 0x90           | R/W | Register for port 1 read and write operations (pins DIO8DIO15)  |
| DIR1     | 0x91           | R/W | Data direction register for port 1.   |
| P2       | 0xA0           | R/W | Register for port 2 read and write operations (pins DIO16DIO21)                                       |
| DIR2     | 0xA1           | R/W | Data direction register for port 2.   |

#### Table 9: Port Registers

All four ports on the chip are bi-directional. Each of them consists of a Latch (SFR 'P0' to 'P3'), an output driver, and an input buffer, therefore the MPU can output or read data through any of these ports if they are not used for alternate purposes.

## Special Function Registers Specific to the 71M6403

Table 10 shows the location and description of the 71M6403-specific SFRs.

| Register | Alternative<br>Name | SFR<br>Address | R/W | Description   |  |
|----------|---------------------|----------------|-----|---|--|
| ERASE    | FLSH_ERASE          | 0x94           | W   | This register is used to initiate either the Flash Mass Erase cycle or the Flash Page Erase cycle. Specific patterns are expected for <i>FLSH_ERASE</i> in order to initiate the appropriate Erase cycle (default = 0x00).  |  |
|          |                     |                |     | 0x55 – Initiate Flash Page Erase cycle. Must be preceded by a write to<br>FLSH_PGADR @ SFR 0xB7.  |  |
|          |                     |                |     | 0xAA – Initiate Flash Mass Erase cycle. Must be preceded by a write to<br>FLSH_MEEN @ SFR 0xB2 and the debug port must be<br>enabled.   |  |
|          |                     |                |     | Any other pattern written to FLSH_ERASE will have no effect.  |  |
| PGADDR   | FLSH_PGADR          | 0xB7           | R/W |   |  |
|          |                     |                |     | Must be re-written for each new Page Erase cycle.   |  |
| EEDATA   |                     | 0x9E           | R/W | I <sup>2</sup> C EEPROM interface data register   |  |
| EECTRL   |                     | 0x9F           | R/W | I <sup>2</sup> C EEPROM interface control register. If the MPU wishes to write a byte of data to EEPROM, it places the data in <i>EEDATA</i> and then writes the 'Transmit' code to <i>EECTRL</i> . The write to <i>EECTRL</i> initiates the transmit sequence. See the section I2C Interface (EEPROM) for a description of the command and status bits available for <i>EECTRL</i> . |  |



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| FLSHCRL |          | 0xB2 | R/W        | Bit 0 (FLSH_PWE): Program Write Enable:         0 – MOVX commands refer to XRAM Space, normal operation         (default).         1 – MOVX @DPTR,A moves A to Program Space (Flash) @ DPTR.         This bit is automatically reset after each byte is written to flash. Writes to this bit are inhibited when interrupts are enabled.  |
|---------|----------|------|------------|--|
|         |          |      | W          | Bit 1 (FLSH_MEEN): Mass Erase Enable:<br>0 – Mass Erase disabled (default).<br>1 – Mass Erase enabled.<br>Must be re-written for each new Mass Erase cycle.  |
|         |          |      | R/W        | Bit 6 (SECURE):<br>Enables security provisions that prevent external reading of flash<br>memory and CE program RAM. This bit is reset on chip reset and may<br>only be set. Attempts to write zero are ignored.  |
|         |          |      | R          | Bit 7 (PREBOOT):<br>Indicates that the preboot sequence is active.   |
| WDI     |          | 0xE8 | R/W<br>R/W | Only byte operations on the whole WDI register should be used<br>when writing. The byte must have all bits set except the bits that are to<br>be cleared.The multi-purpose register WDI contains the following bits:Bit 0 (IE_XFER): XFER Interrupt Flag:<br>This flag monitors the XFER_BUSY interrupt. It is set by hardware and<br>must be cleared by the interrupt Flag:<br>This flag monitors the ZP8 0.8sec interrupt. It is set by hardware and<br>must be cleared by the interrupt Flag: |
| INTBITS | INT0INT6 | 0xF8 | R          | Interrupt inputs. The MPU may read these bits to see the input to external interrupts INT0, INT1, up to INT6. These bits do not have any memory and are primarily intended for debug use. Refer to the External Interrupts description.  |

**Table 10: Special Function Registers** 

## **Instruction Set**

All instructions of the generic 8051 microcontroller are supported. A complete list of the instruction set and of the associated opcodes is contained in the 64xx Software User's Guide (SUG).



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## UART

The 71M6403 includes a UART (UART0) that can be programmed for general purpose communications. A second UART (UART1) is connected to the optical port, as described in the optical port description.

The UART is a dedicated 2-wire serial interface, which can communicate with an external host processor at up to 38,400 bits/s (with MPU clock = 1.2288MHz). The operation of each pin is as follows:

**RX**: Serial input data are applied at this pin. Conforming to RS-232 standard, the bytes are input LSB first. The voltage applied at RX must not exceed 3.6V.

**TX**: This pin is used to output the serial data. The bytes are output LSB first.

The 71M6403 has several UART-related registers, which can be read and written. All UART transfers are programmable for parity enable, parity, 2 stop bits/1 stop bit and XON/XOFF options for variable communication baud rates from 300 to 38400 bps. Table 11 shows how the baud rates are calculated. Table 12 shows the selectable UART operation modes.

|                    | Using Timer 1  | Using Internal Baud Rate Generator                                      |
|--------------------|--|---|
| Serial Interface 0 | 2 <sup>smod</sup> * f <sub>CKMPU</sub> / (384 * (256-TH1)) | 2 <sup>smod</sup> * f <sub>CKMPU</sub> /(64 * (2 <sup>10</sup> -S0REL)) |
| Serial Interface 1 | N/A  | f <sub>CKMPU</sub> /(32 * (2 <sup>10</sup> -S1REL))                     |

**Note:** S0REL and S1REL are 10-bit values derived by combining bits from the respective timer reload registers. SMOD is the SMOD bit in the SFR *PCON*. TH1 is the high byte of timer 1.

#### Table 11: Baud Rate Generation

|        | UART 0   | UART 1  |
|--------|--|---|
| Mode 0 | N/A  | Start bit, 8 data bits, parity, stop bit, variable baud rate (internal baud rate generator) |
| Mode 1 | Start bit, 8 data bits, stop bit,<br>variable baud rate (internal baud<br>rate generator or timer 1)         | Start bit, 8 data bits, stop bit, variable baud rate (internal baud rate generator)         |
| Mode 2 | Start bit, 8 data bits, parity, stop bit, fixed baud rate 1/32 or 1/64 of $f_{\mbox{CKMPU}}$                 | N/A   |
| Mode 3 | Start bit, 8 data bits, parity, stop bit,<br>variable baud rate (internal baud<br>rate generator or timer 1) | N/A   |

### Table 12: UART Modes

Note: Parity of serial data is available through the P flag of the accumulator. Seven-bit serial modes with parity, such as those used by the FLAG protocol, can be simulated by setting and reading bit 7 of 8-bit output data. Seven-bit serial modes without parity can be simulated by setting bit 7 to a constant 1. 8-bit serial modes with parity can be simulated by setting and reading the 9<sup>th</sup> bit, using the control bits S0CON3 and S1CON3 in the S0COn and S1CON SFRs.



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## Serial Interface 0 Control Register (S0CON).

The function of the UART0 depends on the setting of the Serial Port Control Register S0CON.

| SB  |     |      |      |      |      |     | LSB |
|-----|-----|------|------|------|------|-----|-----|
| SM0 | SM1 | SM20 | REN0 | TB80 | RB80 | T10 | RI0 |

#### Table 13: The S0CON Register

#### Serial Interface 1 Control Register (S1CON).

The function of the serial port depends on the setting of the Serial Port Control Register S1CON.

| MSB |   |      |      |      |      |     | LSB |  |
|-----|---|------|------|------|------|-----|-----|--|
| SM  | - | SM21 | REN1 | TB81 | RB81 | TI1 | RI1 |  |

| Table 14 | The | S1CON | register |
|----------|-----|-------|----------|
|----------|-----|-------|----------|

| Bit      | Symbol | Function  |   |                |                  |            |  |
|----------|--------|---|---|----------------|------------------|------------|--|
| S0CON.7  | SM0    | These two bits  | set the UART0 m                               | ode:           |                  |            |  |
|          |        | Mode  | Description                                   | SM0            | SM1              |            |  |
|          |        | 0   | N/A   | 0              | 0                |            |  |
| S0CON.6  | SM1    | 1   | 8-bit UART                                    | 0              | 1                |            |  |
| 000011.0 | Givit  | 2   | 9-bit UART                                    | 1              | 0                |            |  |
|          |        | 3   | 9-bit UART                                    | 1              | 1                |            |  |
| S0CON.5  | SM20   | Enables the int   | er-processor com                              | munication fea | ture.            |            |  |
| S0CON.4  | REN0   | If set, enables   | serial reception. C                           | leared by soft | ware to disable  | reception. |  |
| S0CON.3  | TB80   |   | itted data bit in Mong on the function netc.) |                |                  |            |  |
| S0CON.2  | RB80   | In Modes 2 and 3 it is the 9 <sup>th</sup> data bit received. In Mode 1, if SM20 is 0, RB80 is the stop bit. In Mode 0 this bit is not used. Must be cleared by software. |   |                |                  |            |  |
| S0CON.1  | ТІО    | Transmit interrupt flag, set by hardware after completion of a serial transfer. Must be cleared by software.  |   |                |                  |            |  |
| S0CON.0  | RI0    |   | ipt flag, set by har<br>t be cleared by so    |                | mpletion of a se | erial      |  |

Table 15: The S0CON Bit Functions



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| Bit     | Symbol | Function     | Function   |  |   |       |  |  |  |  |
|---------|--------|--------------|--|--|---|-------|--|--|--|--|
| S1CON.7 | SM     | Sets the ba  | Sets the baud rate for UART1   |  |   |       |  |  |  |  |
|         |        | SM           | Mode   | Description                              | Baud Rate                                     |       |  |  |  |  |
|         |        | 0            | A  | 9-bit UART                               | variable                                      |       |  |  |  |  |
|         |        | 1            | В  | 8-bit UART                               | variable                                      |       |  |  |  |  |
| S1CON.5 | SM21   | Enables th   | e inter-proce  | ssor communicatior                       | n feature.                                    |       |  |  |  |  |
| S1CON.4 | REN1   | If set, enab | If set, enables serial reception. Cleared by software to disable reception.                                  |  |   |       |  |  |  |  |
| S1CON.3 | TB81   |              | on the funct   |  | or cleared by the M<br>ty check, multiproce   |       |  |  |  |  |
| S1CON.2 | RB81   |              |  |  | ved. In Mode B, if si<br>t used. Must be clea |       |  |  |  |  |
| S1CON.1 | TI1    |              | Transmit interrupt flag, set by hardware after completion of a serial transfer. Must be cleared by software. |  |   |       |  |  |  |  |
| S1CON.0 | RI1    |              |  | set by hardware afte<br>red by software. | r completion of a se                          | erial |  |  |  |  |

Table 16: The S1CON Bit Functions



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### **Timers and Counters**

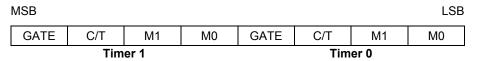
The 80515 has two 16-bit timer/counter registers: Timer 0 and Timer 1. These registers can be configured for counter or timer operations.

In timer mode, the register is incremented every machine cycle meaning that it counts up after every 12 periods of the MPU clock signal.

In counter mode, the register is incremented when the falling edge is observed at the corresponding input signal T0 or T1 (T0 and T1 are the timer gating inputs derived from certain DIO pins, see the DIO Ports chapter). Since it takes 2 machine cycles to recognize a 1-to-0 event, the maximum input count rate is 1/2 of the oscillator frequency. There are no restrictions on the duty cycle, however to ensure proper recognition of 0 or 1 state, an input should be stable for at least 1 machine cycle.

Four operating modes can be selected for Timer 0 and Timer 1. Two Special Function Registers (TMOD and TCON) are used to select the appropriate mode.

#### Timer/Counter Mode Control register (TMOD):



#### Table 17: The TMOD Register

Bits TR1 and TR0 start their associated timers when set.

| Bit              | Symbol | Function  |
|------------------|--------|---|
| TMOD.7<br>TMOD.3 | Gate   | If set, enables external gate control (pin int0 or int1 for Counter 0 or 1, respectively). When int0 or int1 is high, and TRX bit is set (see TCON register), a counter is incremented every falling edge on t0 or t1 input pin |
| TMOD.6<br>TMOD.2 | C/T    | Selects Timer or Counter operation. When set to 1, a Counter operation is performed. When cleared to 0, the corresponding register will function as a Timer.  |
| TMOD.5<br>TMOD.1 | M1     | Selects the mode for Timer/Counter 0 or Timer/Counter 1, as shown in TMOD description.  |
| TMOD.4<br>TMOD.0 | M0     | Selects the mode for Timer/Counter 0 or Timer/Counter 1, as shown in TMOD description.  |

#### Table 18: TMOD Register Bit Description



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| M1 | MO | Mode   | Function  |
|----|----|--------|---|
| 0  | 0  | Mode 0 | 13-bit Counter/Timer with 5 lower bits in the TL0 or TL1 register and the remaining 8 bits in the TH0 or TH1 register (for Timer 0 and Timer 1, respectively). The 3 high order bits of TL0 and TL1 are held at zero. |
| 0  | 1  | Mode 1 | 16-bit Counter/Timer.   |
| 1  | 0  | Mode2  | 8-bit auto-reload Counter/Timer. The reload value is kept in TH0 or TH1, while TL0 or TL1 is incremented every machine cycle. When $TL(x)$ overflows, a value from TH(x) is copied to TL(x).                          |
| 1  | 1  | Mode3  | If Timer 1 M1 and M0 bits are set to '1', Timer 1 stops. If Timer 0 M1 and M0 bits are set to '1', Timer 0 acts as two independent 8-bit Timer/Counters.  |

### Table 19: Timers/Counters Mode Description

Note: TL0 is affected by TR0 and gate control bits, and sets TF0 flag on overflow. TH0 is affected by TR1 bit, and sets TF1 flag on overflow.

### Timer/Counter Control Register (TCON)

| MSB |     |     |     |     |     |     |     |     |  |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|--|
|     | TF1 | TR1 | TF0 | TR0 | IE1 | IT1 | IE0 | IT0 |  |

### Table 20: The TCON Register

| Bit                      | Symbol   | Function   |  |  |
|--------------------------|--|--|--|--|
| TCON.7                   | TF1  | The Timer 1 overflow flag is set by hardware when Timer 1 overflows. This flag can be cleared by software and is automatically cleared when an interrupt is processed. |  |  |
| TCON.6                   | TCON.6 TR1 Timer 1 Run control bit. If cleared, Timer 1 stops. |  |  |  |
| TCON.5 TF0               |  | Timer 0 overflow flag set by hardware when Timer 0 overflows. This flag can be cleared by software and is automatically cleared when an interrupt is processed.        |  |  |
| TCON.4                   | TR0  | Timer 0 Run control bit. If cleared, Timer 0 stops.  |  |  |
| TCON.3                   | IE1  | Interrupt 1 edge flag is set by hardware when the falling edge on external pin int1 is observed. Cleared when an interrupt is processed.                               |  |  |
| TCON.2                   | IT1  | Interrupt 1 type control bit. Selects either the falling edge or low level on input pin to cause an interrupt.   |  |  |
| TCON.1 IE0<br>TCON.0 IT0 |  | Interrupt 0 edge flag is set by hardware when the falling edge on external pin int0 is observed. Cleared when an interrupt is processed.                               |  |  |
|                          |  | Interrupt 0 type control bit. Selects either the falling edge or low level on input pin to cause interrupt.  |  |  |

#### Table 21: The TCON Register Bit Functions



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Table 22 specifies the combinations of operation modes allowed for timer 0 and timer 1:

|                  |             | Timer 1     |        |  |  |  |  |  |
|------------------|-------------|-------------|--------|--|--|--|--|--|
|                  | Mode 0      | Mode 1      | Mode 2 |  |  |  |  |  |
| Timer 0 - mode 0 | YES         | YES         | YES    |  |  |  |  |  |
| Timer 0 - mode 1 | YES         | YES         | YES    |  |  |  |  |  |
| Timer 0 - mode 2 | Not allowed | Not allowed | YES    |  |  |  |  |  |

Table 22: Timer Modes

Timer/Counter Mode Control register (PCON):

| MSB  |      |      |      | LSB |  |
|------|------|------|------|-----|--|
| SMOD | <br> | <br> | <br> |     |  |

Table 23: The PCON Register

The SMOD bit in the PCON register doubles the baud rate when set.

| Bit    | Symbol | Function |
|--------|--------|----------|
| PCON.7 | SMOD   |          |

### Table 24: PCON Register Bit Description



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## WD Timer (Software Watchdog Timer)

The software watchdog timer is a 16-bit counter that is incremented once every 24 or 384 clock cycles. After a reset, the watchdog timer is disabled and all registers are set to zero. The watchdog consists of a 16-bit counter (WDT), a reload register (WDTREL), prescalers (by 2 and by 16), and control logic. Once the watchdog is started, it cannot be stopped unless the internal reset signal becomes active.

#### Note: It is recommended to use the hardware watchdog timer instead of the software watchdog timer.

**WD Timer Start Procedure:** The WDT is started by setting the SWDT flag. When the WDT register enters the state 0x7CFF, an asynchronous WDTS signal will become active. The signal WDTS sets bit 6 in the IP0 register and requests a reset state. WDTS is cleared either by the reset signal or by changing the state of the WDT timer.

**Refreshing the WD Timer:** The watchdog timer must be refreshed regularly to prevent the reset request signal from becoming active. This requirement imposes an obligation on the programmer to issue two instructions. The first instruction sets WDT and the second instruction sets SWDT. The maximum delay allowed between setting WDT and SWDT is 12 clock cycles. If this period has expired and SWDT has not been set, WDT is automatically reset, otherwise the watchdog timer is reloaded with the content of the WDTREL register and WDT is automatically reset.

#### Special Function Registers for the WD Timer

#### Interrupt Enable 0 Register (IEN0):

| I | MSB |     |     |     |     |     |     | LSB |  |
|---|-----|-----|-----|-----|-----|-----|-----|-----|--|
|   | EAL | WDT | ET2 | ES0 | ET1 | EX1 | ET0 | EX0 |  |

#### Table 25: The IEN0 Register

| Bit    | Symbol | Function  |
|--------|--------|---|
| IEN0.6 | WDT    | Watchdog timer refresh flag.  |
|        |        | Set to initiate a refresh of the watchdog timer. Must be set directly before SWDT is set to prevent an unintentional refresh of the watchdog timer. WDT is reset by hardware 12 clock cycles after it has been set. |

#### Table 26: The IEN0 Bit Functions

Note: The remaining bits in the IEN0 register are not used for watchdog control

#### Interrupt Enable 1 Register (IEN1):

| MSB   |      |     |     |     |     |     | LSB |
|-------|------|-----|-----|-----|-----|-----|-----|
| EXEN2 | SWDT | EX6 | EX5 | EX4 | EX3 | EX2 |     |

#### Table 27: The IEN1 Register

| Bit    | Symbol | Function   |
|--------|--------|--|
| IEN1.6 | SWDT   | Watchdog timer start/refresh flag.   |
|        |        | Set to activate/refresh the watchdog timer. When directly set after setting WDT, a watchdog timer refresh is performed. Bit SWDT is reset by the hardware 12 clock cycles after it has been set. |

#### Table 28: The IEN1 Bit Functions

Note: The remaining bits in the IEN1 register are not used for watchdog control

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## Interrupt Priority 0 Register (IP0):

| MSB |      |       |       |       |       |       | LSB   |
|-----|------|-------|-------|-------|-------|-------|-------|
|     | WDTS | IP0.5 | IP0.4 | IP0.3 | IP0.2 | IP0.1 | IP0.0 |

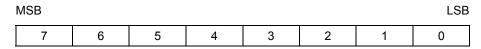
### Table 29: The IP0 Register

| Bit   | Symbol | Function  |
|-------|--------|---|
| IP0.6 | WDTS   | Watchdog timer status flag. Set when the watchdog timer was started. Can be read by software. |

#### Table 30: The IP0 bit Functions

Note: The remaining bits in the IP0 register are not used for watchdog control

### Watchdog Timer Reload Register (WDTREL):



#### Table 31: The WDTREL Register

| Bit                        | Symbol | Function   |
|----------------------------|--------|--|
| WDTREL.7                   | 7      | Prescaler select bit. When set, the watchdog is clocked through an additional divide-by-16 prescaler   |
| WDTREL.6<br>to<br>WDTREL.0 | 6-0    | Seven bit reload value for the high-byte of the watchdog timer. This value is loaded to the WDT when a refresh is triggered by a consecutive setting of bits WDT and SWDT. |

#### Table 32: The WDTREL Bit Functions

The WDTREL register can be loaded and read at any time.



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#### Interrupts

The 80515 provides 11 interrupt sources with four priority levels. Each source has its own request flag(s) located in a special function register (TCON, IRCON, and SCON). Each interrupt requested by the corresponding flag can be individually enabled or disabled by the enable bits in SFRs IEN0, IEN1, and IEN2.

External interrupts are the interrupts external to the 80515 core, i.e. signals that originate in other parts of the 71M6403, such as the CE, DIO, EEPROM interface, comparators.

**Interrupt Overview:** When an interrupt occurs, the MPU will vector to the predetermined address as shown in Table 50. Once interrupt service has begun, it can be interrupted only by a higher priority interrupt. The interrupt service is terminated by a return from instruction, "RETI". When an RETI is performed, the processor will return to the instruction that would have been next when the interrupt occurred.

When the interrupt condition occurs, the processor will also indicate this by setting a flag bit. This bit is set regardless of whether the interrupt is enabled or disabled. Each interrupt flag is sampled once per machine cycle, then samples are polled by the hardware. If the sample indicates a pending interrupt when the interrupt is enabled, then the interrupt request flag is set. On the next instruction cycle, the interrupt will be acknowledged by hardware forcing an LCALL to the appropriate vector address.

Interrupt response will require a varying amount of time depending on the state of the MPU when the interrupt occurs. If the MPU is performing an interrupt service with equal or greater priority, the new interrupt will not be invoked. In other cases, the response time depends on the current instruction. The fastest possible response to an interrupt is 7 machine cycles. This includes one machine cycle for detecting the interrupt and six cycles to perform the LCALL.

### **Special Function Registers for Interrupts:**

#### Interrupt Enable 0 register (IE0)

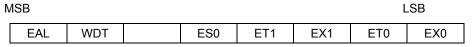


Table 33: The IEN0 Register

| Bit    | Symbol | Function                                   |
|--------|--------|--|
| IEN0.7 | EAL    | EAL=0 – disable all interrupts             |
| IEN0.6 | WDT    | Not used for interrupt control             |
| IEN0.5 | -      |  |
| IEN0.4 | ES0    | ES0=0 – disable serial channel 0 interrupt |
| IEN0.3 | ET1    | ET1=0 – disable timer 1 overflow interrupt |
| IEN0.2 | EX1    | EX1=0 – disable external interrupt 1       |
| IEN0.1 | ET0    | ET0=0 – disable timer 0 overflow interrupt |
| IEN0.0 | EX0    | EX0=0 – disable external interrupt 0       |

#### Table 34: The IEN0 Bit Functions



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## Interrupt Enable 1 Register (IEN1)

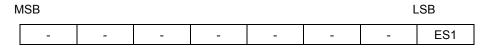
| MSB |      |     |     |     | L   | SB  |  |
|-----|------|-----|-----|-----|-----|-----|--|
|     | SWDT | EX6 | EX5 | EX4 | EX3 | EX2 |  |

## Table 35: The IEN1 Register

| Bit    | Symbol | Function                             |
|--------|--------|--------------------------------------|
| IEN1.7 | -      |                                      |
| IEN1.6 | SWDT   | Not used for interrupt control       |
| IEN1.5 | EX6    | EX6=0 – disable external interrupt 6 |
| IEN1.4 | EX5    | EX5=0 – disable external interrupt 5 |
| IEN1.3 | EX4    | EX4=0 – disable external interrupt 4 |
| IEN1.2 | EX3    | EX3=0 – disable external interrupt 3 |
| IEN1.1 | EX2    | EX2=0 – disable external interrupt 2 |
| IEN1.0 | -      |                                      |

## Table 36: The IEN1 Bit Functions

### Interrupt Enable 2 register (IE2)



#### Table 37: The IEN2 Register

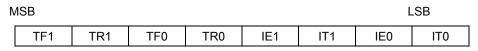
| Bit    | Symbol | Function                                   |
|--------|--------|--|
| IEN2.0 | ES1    | ES1=0 – disable serial channel 1 interrupt |

### Table 38: The IEN2 Bit Functions



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### Timer/Counter Control register (TCON)

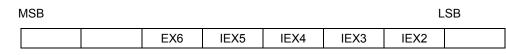


## Table 39: The TCON Register

| Bit    | Symbol | Function                              |
|--------|--------|---------------------------------------|
| TCON.7 | TF1    | Timer 1 overflow flag                 |
| TCON.6 | TR1    | Not used for interrupt control        |
| TCON.5 | TF0    | Timer 0 overflow flag                 |
| TCON.4 | TR0    | Not used for interrupt control        |
| TCON.3 | IE1    | External interrupt 1 flag             |
| TCON.2 | IT1    | External interrupt 1 type control bit |
| TCON.1 | IE0    | External interrupt 0 flag             |
| TCON.0 | IT0    | External interrupt 0 type control bit |

## Table 40: The TCON Bit Functions

### Interrupt Request register (IRCON)



### Table 41: The IRCON Register

| Bit     | Symbol | Function                       |
|---------|--------|--------------------------------|
| IRCON.7 | -      |                                |
| IRCON.6 | -      |                                |
| IRCON.5 | IEX6   | External interrupt 6 edge flag |
| IRCON.4 | IEX5   | External interrupt 5 edge flag |
| IRCON.3 | IEX4   | External interrupt 4 edge flag |
| IRCON.2 | IEX3   | External interrupt 3 edge flag |
| IRCON.1 | IEX2   | External interrupt 2 edge flag |
| IRCON.0 | -      |                                |

## Table 42: The IRCON Bit Functions

Note: Only TF0 and TF1 (timer 0 and timer 1 overflow flag) will be automatically cleared by hardware when the service routine is called (Signals T0ACK and T1ACK – port ISR – active high when the service routine is called).



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## **External Interrupts**

The external interrupts are connected as shown in Table 43. The polarity of interrupts 2 and 3 is programmable in the MPU. Interrupts 2 and 3 should be programmed for falling sensitivity. The generic 8051 MPU literature states that interrupts 4 through 6 are defined as rising edge sensitive. Thus, the hardware signals attached to interrupts 5 and 6 are inverted to achieve the edge polarity shown in Table 43.

SFR (special function register) enable bits must be set to permit any of these interrupts to occur. Likewise, each interrupt has its own flag bit that is set by the interrupt hardware and is reset automatically by the MPU interrupt handler (0 through 5). ZP8 has its own enable and flag bits in addition to the interrupt 6 enable and flag bits (see Table 44). The ZP8 interrupt must be cleared by the MPU software. The ZP8 interrupt occurs every 853.4 msec.

| External<br>Interrupt | Connection                | Polarity   | Flag Reset |
|-----------------------|---------------------------|------------|------------|
| 0                     | Digital I/O High Priority | see DIO_Rx | automatic  |
| 1                     | Digital I/O Low Priority  | see DIO_Rx | automatic  |
| 2                     | Comparator 2 or 3         | falling    | automatic  |
| 3                     | Reserved                  |            |            |
| 4                     | Comparator 2 or 3         | rising     | automatic  |
| 5                     | EEPROM busy               | falling    | automatic  |
| 6                     | ZP8                       | falling    | manual     |

Interrupt 6 is edge-sensitive. The flag for the ZP8 interrupt is located in the WDI SFR (address 0xE8).

| Enable Bit | Description                 |  |  |  |
|------------|-----------------------------|--|--|--|
| EX0        | Enable external interrupt 0 |  |  |  |
| EX1        | Enable external interrupt 1 |  |  |  |
| EX2        | Enable external interrupt 2 |  |  |  |
| EX3        | Enable external interrupt 3 |  |  |  |
| EX4        | Enable external interrupt 4 |  |  |  |
| EX5        | Enable external interrupt 5 |  |  |  |
| EX6        | Enable external interrupt 6 |  |  |  |
| EX_ZP8     | Enable ZP8 interrupt        |  |  |  |

| Flag Bit | Description               |  |  |  |
|----------|---------------------------|--|--|--|
| IE0      | External interrupt 0 flag |  |  |  |
| IE1      | External interrupt 1 flag |  |  |  |
| IEX2     | External interrupt 2 flag |  |  |  |
| IEX3     | External interrupt 3 flag |  |  |  |
| IEX4     | External interrupt 4 flag |  |  |  |
| IEX5     | External interrupt 5 flag |  |  |  |
| IEX6     | External interrupt 6 flag |  |  |  |
| IE_ZP8   | ZP8 interrupt flag        |  |  |  |

**Table 44: Control Bits for External Interrupts** 



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### Interrupt Priority Level Structure

All interrupt sources are combined in groups, as shown in Table 45:

| Group |                            |                            |                      |
|-------|----------------------------|----------------------------|----------------------|
| 0     | External interrupt 0       | Serial channel 1 interrupt |                      |
| 1     | Timer 0 interrupt          | -                          | External interrupt 2 |
| 2     | External interrupt 1       | -                          | External interrupt 3 |
| 3     | Timer 1 interrupt          | -                          | External interrupt 4 |
| 4     | Serial channel 0 interrupt | -                          | External interrupt 5 |
| 5     | -                          | -                          | External interrupt 6 |

#### **Table 45: Priority Level Groups**

Each group of interrupt sources can be programmed individually to have one of four priority levels by setting or clearing one bit in the special function register IP0 and one in IP1. If requests of the same priority level are received simultaneously, an internal polling sequence as per Table 49 determines which request is serviced first.

IEN enable bits must be set to permit any of these interrupts to occur. Likewise, each interrupt has its own flag bit that is set by the interrupt hardware and is reset automatically by the MPU interrupt handler (0 through 5). ZP8 has its own enable and flag bits in addition to the interrupt 6 enable and flag bits (see Table 44). Note, the ZP8 interrupt must be cleared by the MPU software.

#### Interrupt Priority 0 Register (IP0)

| Ν | ISB |      |       |       |       |       | L     | SB    |
|---|-----|------|-------|-------|-------|-------|-------|-------|
|   |     | WDTS | IP0.5 | IP0.4 | IP0.3 | IP0.2 | IP0.1 | IP0.0 |

Table 46: The IP0 Register:

Note: WDTS is not used for interrupt control

#### Interrupt Priority 1 Register (IP1)

MSB

LSB

| - | - | IP1.5 | IP1.4 | IP1.3 | IP1.2 | IP1.1 | IP1.0 |
|---|---|-------|-------|-------|-------|-------|-------|

#### Table 47: The IP1 Register:

| IP1.x | IP0.x | Priority Level   |
|-------|-------|------------------|
| 0     | 0     | Level0 (lowest)  |
| 0     | 1     | Level1           |
| 1     | 0     | Level2           |
| 1     | 1     | Level3 (highest) |

#### **Table 48: Priority Levels**



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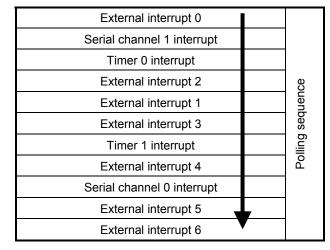


 Table 49: Interrupt Polling Sequence

## **Interrupt Sources and Vectors**

Table 50 shows the interrupts with their associated flags and vector addresses.

| Interrupt Request Flag | Description                | Interrupt Vector Address |
|------------------------|----------------------------|--------------------------|
| IE0                    | External interrupt 0       | 0x0003                   |
| TF0                    | Timer 0 interrupt          | 0x000B                   |
| IE1                    | External interrupt 1       | 0x0013                   |
| TF1                    | Timer 1 interrupt          | 0x001B                   |
| RI0/TI0                | Serial channel 0 interrupt | 0x0023                   |
| RI1/TI1                | Serial channel 1 interrupt | 0x0083                   |
| IEX2                   | External interrupt 2       | 0x004B                   |
| IEX3                   | External interrupt 3       | 0x0053                   |
| IEX4                   | External interrupt 4       | 0x005B                   |
| IEX5                   | External interrupt 5       | 0x0063                   |
| IEX6                   | External interrupt 6       | 0x006B                   |

**Table 50: Interrupt Vectors** 



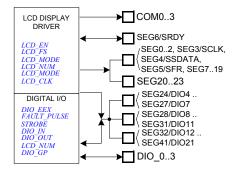
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## **On-Chip Resources**

### **DIO Ports**

The 71M6402 includes up to 22 pins of general purpose digital I/O. 18 of these pins are dual function and can alternatively be used as LCD drivers. Figure 6 shows a block diagram of the DIO section.

On reset or power-up, all DIO pins are inputs until they are configured for the desired direction. The pins are configured and controlled by the *DIO* and *DIO\_DIR* registers (SFRs) and by the five bits of the I/O register *LCD\_NUM* (0x2020[4:0]). See the description for *LCD\_NUM* in the I/O RAM Section for a table listing the available segment pins versus DIO pins, depending on the selection for *LCD\_NUM*. Generally, increasing the value for *LCD\_NUM* will configure an increasing number of general purpose pins to be LCD segment pins, starting at the higher pin numbers.



#### Figure 6: DIO Ports Block Diagram

Each pin declared as DIO can be configured independently as an input or output with the bits of the *DIO\_DIRn* registers. Table 51 lists the direction registers and configurability associated with each group of DIO pins. Table 52 shows the configuration for a DIO pin through its associated bit in its *DIO\_DIR* register.

| DIO Pin Group | Туре      | MPU<br>Port | Direction<br>Register<br>Name | Direction<br>Register<br>(SFR)<br>Location | Data<br>Register<br>Name | Data Re-<br>gister<br>(SFR)<br>Location | Internal resources<br>selectable when<br>configured as DIO |
|---------------|-----------|-------------|-------------------------------|--|--------------------------|---|--|
| DIO_0DIO_3    | DIO only  | P0          | DIR0                          | 0xA2 [3:0]                                 | P0                       | 0x80 [3:0]                              | Yes  |
| DIO 4DIO7     | Multi-use | P0          | DIRU                          | 0xA2 [7:4]                                 | FU                       | 0x80 [7:4]                              | Yes  |
| DIO 8DIO11    | Multi-use | P1          | DIR1                          | 0x91 [3:0]                                 | P1                       | 0x90 [3:0]                              | Yes  |
| DIO 12DIO15   | Multi-use | P1          |                               | 0x91[7:4]                                  |                          | 0x90[7:4]                               | No   |
| DIO 16DIO21   | Multi-use | P2          | DIR2                          | 0xA1[5:0]                                  | P2                       | 0xA0[5:0]                               | No   |

#### Table 51: Direction Registers and Internal Resources for DIO Pin Groups

|                         | DIO_DIR bit |        |  |
|-------------------------|-------------|--------|--|
|                         | 0           | 1      |  |
| <b>DIO Pin Function</b> | input       | output |  |

Table 52: DIO\_DIR Control Bit



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Values read from and written into the DIO ports use the data registers P0, P1 and P2.

A 3-bit configuration word, I/O RAM register,  $DIO_Rx$  (0x2009[2:0] through 0x200E[6:4]) can be used for certain pins, when configured as DIO, to individually assign an internal resource such as an interrupt or a timer control (see Table 51 for DIO pins available for this option). This way, DIO pins can be tracked even if they are configured as outputs. This feature is useful for pulse counting. The control resources selectable for the DIO pins are listed in Table 53. If more than one input is connected to the same resource, the resources are combined using a logical OR.

| <i>DIO_R</i><br>Value | Resource Selected for DIO Pin              |
|-----------------------|--|
| 0                     | NONE                                       |
| 1                     | Reserved                                   |
| 2                     | T0 (counter0 clock)                        |
| 3                     | T1 (counter1 clock)                        |
| 4                     | High priority I/O interrupt (INT0 rising)  |
| 5                     | Low priority I/O interrupt (INT1 rising)   |
| 6                     | High priority I/O interrupt (INT0 falling) |
| 7                     | Low priority I/O interrupt (INT1 falling)  |

Table 53: Selectable Controls using the *DIO\_DIR* Bits

Additionally, if DIO6 and DIO7 are declared outputs, they can be configured as dedicated pulse outputs (STROBE = DIO6, FAULT\_PULSE = DIO7) using the I/O RAM registers  $DIO_PW$  (0x2008[2]) and  $DIO_PV$  (0x2008[3]). In this case, DIO6 and DIO7 are under CE control. DIO4 and DIO5 can be configured to implement the EEPROM Interface by setting the I/O RAM register  $DIO_EEX$  (0x2008[4]).

## **Physical Memory**

Data bus address space is allocated to on-chip memory as shown in Table 54.

| Address<br>(hex) | Memory<br>Technology | Memory Type      | Typical Usage                  | Wait States<br>(at 5MHz) | Memory Size<br>(bytes) |
|------------------|----------------------|------------------|--------------------------------|--------------------------|------------------------|
| 0000-FFFF        | Flash Memory         | Non-volatile     | Program and non-volatile data  | 0                        | 64KB                   |
| 0000-07FF        | Static RAM           | Battery-buffered | MPU data XRAM,                 | 0                        | 2KB                    |
| 1000-13FF        | Static RAM           | Volatile         | CE data                        | 5                        | 1KB                    |
| 2000-20FF        | Static RAM           | Volatile         | configuration RAM<br>(I/O RAM) | 0                        | 256                    |
| 3000-3FFF        | Static RAM           | Volatile         | CE Program code                | 5                        | 4KB                    |

### Table 54: MPU Data Memory Map

**Flash Memory:** The 71M6403 includes 64KB of on-chip flash memory. The flash memory is intended to primarily contain MPU program code. In a typical application, it also contains images of the CE program code, CE coefficients, MPU RAM, and I/O RAM. On power-up, before enabling the CE, the MPU must copy these images to their respective memory locations.

The I/O RAM bit register *FLASH66Z* defines the pulse width for accessing flash memory. **To minimize supply current draw, this bit should be set to 1**.

Flash erasure is initiated by writing a specific data pattern to specific SFR registers in the proper sequence. These special pattern/sequence requirements prevent inadvertent erasure of the flash memory.



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The mass erase sequence is:

- 1. Write 1 to the FLSH\_MEEN bit (SFR address 0xB2[1].
- 2. Write pattern 0xAA to FLSH\_ERASE (SFR address 0x94)

Note: The mass erase cycle can only be initiated when the ICE port is enabled.

The page erase sequence is:

- 1. Write the page address to *FLSH\_PGADR* (SFR address 0xB7[7:1]
- 2. Write pattern 0x55 to *FLSH\_ERASE* (SFR address 0x94)

The MPU may write to the flash memory. This is one of the non-volatile storage options available to the user. The I/O RAM register *FLSH\_PWE* (flash program write enable, SFR B2[0]) differentiates 80515 data store instructions (MOVX@DPTR,A) between Flash and XRAM writes. Before setting *FLSH\_PWE*, all interrupts need to be disabled by setting EAL =1.

Note: Flash write operations in the range 0x2000 to 0x20FF will also affect the I/O RAM. Thus, flash writes to this range have to be either avoided (code must jump around the affected range), or they must contain the data that the I/O RAM expects.

**MPU RAM**: The 71M6403 includes 2KB of static RAM memory on-chip (XRAM), which are backed-up by the battery plus 256bytes of internal RAM in the MPU core. The 2KB of static RAM are used for data storage during normal MPU operations.

**CE Data RAM:** The CE DRAM is the data memory of the CE. The MPU can read and write the CE DRAM as the primary means of data communication between the two processors.

**CE Program RAM:** The CE PRAM is the program memory of the CE. The CE PRAM has to be loaded with CE code before the CE starts operating. CE PRAM cannot be accessed by the MPU when the CE is running.

#### Real-Time Clock (RTC)

The RTC is driven directly by an external clock signal provided at the CK38 pin. In the absence of the 3.3V supply, the RTC is powered by the external battery (VBAT pin). The RTC consists of a counter chain and output registers. The counter chain consists of seconds, minutes, hours, day of week, day of month, month, and year. The RTC is capable of processing leap years. Each counter has its own output register. Whenever the MPU reads the seconds register, all other output registers are automatically updated. Since the RTC clock is not coherent to the MPU clock, the MPU must read the seconds register multiple times until two consecutive reads are the same (requires either 2 or 3 reads). At this point, all RTC output registers will have the correct time. Regardless of the MPU clock speed, RTC reads require one wait state.

The RTC interrupt must be enabled using the I/O RAM register *EX\_RTC* (address 0x2002[1]). RTC time is set by writing to the I/O RAM registers *RTC\_SEC*, *RTC\_MIN*, through *RTC\_YR*. Each byte written to RTC must be delayed at least 3 CK38 cycles from any previous byte written to the RTC.

The RTC counter chain is designed for use with a 32.768 kHz clock source. The 71M6403 requires a 19.6608 MHz master clock for proper CE filter operation. The external (low cost) 'HC4040 counter generates an approximate clock frequency for the RTC. The 'HC4040's divide-by-512 output provides a 38.4 kHz clock signal. Therefore, the RTC runs about 17% faster using the 'HC4040. A divide-by-600 would generate the ideal 32.768 kHz clock from the 19.6608 MHz oscillator. Alternatively, a 32.768 kHz clock can be sourced independently from the system.

Two time-correction bits, the I/O RAM registers *RTC\_DEC\_SEC* (0x201C[1]) and *RTC\_INC\_SEC* (0x201C[0]) are provided to adjust the RTC time. A pulse on one of these bits causes the time to be decremented or incremented by an additional second at the next update of the *RTC\_SEC* register. Thus, if the temperature coefficient of the clock source at the CK38 pin is known, the MPU firmware can integrate temperature and correct the RTC time as necessary as discussed in temperature compensation.



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#### Comparators (V2, INEUTRAL)

The 71M6403 includes two programmable comparators that are connected to the V2 (comparator 2) and INEUTRAL (comparator 3) pins. The I/O RAM register *COMP\_INT* (0x2003[4:3]) allows the user to determine if comparators 2 and 3 will trigger an interrupt to the MPU. The output of each comparator is available in the *COMPSTAT* register. VBIAS is used as the threshold, and built-in hysteresis prevents each comparator from repeatedly responding to low-amplitude noise.

Comparators 2 and 3 can be used for early warning of power faults, or for monitoring of battery or other DC voltages. If they are both selected to interrupt the MPU, their outputs will be XORed together. The voltage at INEUTRAL is also available to the ADC in the AFE, but the comparator should not be used when INEUTRAL is used for analog measurements.

#### **LCD Drivers**

The 71M6403 contains 24 dedicated LCD segment drivers and an additional 18 multi-purpose pins which may be configured as additional LCD segment drivers (see I/O RAM register *LCD\_NUM*). The 71M6403 is capable of driving between 96 to 168 pixels of LCD display with 25% duty cycle. At seven segments per digit, the LCD can be designed for 13 to 24 digits for display. Since each pixel is addressed individually, the LCD display can be a combination of alphanumeric digits and enunciator symbols. The information to be displayed is written into the lower four bits of I/O RAM registers *LCD\_SEG0* through *LCD\_SEG41*. Bit 0 corresponds to the segment selected when COM0 pin is active while bit 1 is allocated to COM1.

The LCD driver circuitry is grouped into 4 common outputs (COM0 to COM3) and up to 42 segment outputs (see Table 55). The typical LCD map is shown below.

|      | SEG0 | SEG1 | SEG2 | SEG3 | <br>SEG30 | <br>SEG41 |
|------|------|------|------|------|-----------|-----------|
| COM0 | P0   | P4   | P8   | P12  | <br>P108  | <br>P164  |
| COM1 | P1   | P5   | P9   | P13  | <br>P109  | <br>P165  |
| COM2 | P2   | P6   | P10  | P14  | <br>P110  | <br>P166  |
| СОМЗ | P3   | P7   | P11  | P15  | <br>P111  | <br>P167  |

#### Table 55: Liquid Crystal Display Segment Table (Typical)

Note: P0, P1, ... Represent the pixel/segment numbers on the LCD.

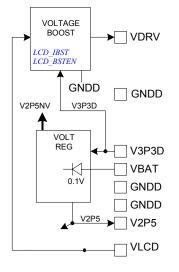
A charge pump suitable for driving VLCD is included on-chip. This circuit creates 5V from the 3.3V supply. A contrast DAC is provided that permits the LCD full-scale voltage to be adjusted between VLCD and 70% of VLCD. The *LCD\_NUM* register defines the number of dual purpose pins used for LCD segment interface.

### LCD Voltage Boost Circuitry

A voltage boost circuit may be used to generate 5V from the 3.3V supply to support low-power 5V devices, such as LCDs. Figure 7 shows a block diagram of the voltage boost circuitry including the voltage regulators for V2P5 and V2P5NV. When activated using the I/O RAM register *LCD\_BSTEN* (0x2020[7]), the boost circuitry provides an AC voltage at the VDRV output pin (see the Applications section for details).



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#### Figure 7: LCD Voltage Boost Circuitry

### UART (UART0) and Optical Port (UART1)

The 71M6403 includes an interface to implement an IR or optical port. The pin OPT\_TX is designed to directly drive an external LED for transmitting data on an optical link (low-active). The pin OPT\_RX, also low-active, is designed to sense the input from an external photo detector used as the receiver for the optical link. These two pins are connected to a dedicated UART port. OPT\_TX can be tristated if it is desired to multiplex another I/O pin to the OPT\_TX output. The control bit for the OPT\_TX output is the I/O RAM register *OPT\_TXDIS* (0x2008[5]).

#### Hardware Reset Mechanisms

Several conditions will cause a hardware reset of the 71M6403:

- Voltage at the RESETZ pin low
- Voltage at the E\_RST pin low

#### Reset Pin (RESETZ)

When the RESETZ pin is pulled low, all digital activity in the chip stops while analog circuits are still active. Additionally, all I/O RAM bits are cleared.

#### Hardware Watchdog Timer

In addition to the basic software watchdog timer included in the 80515 MPU, an independent, robust, fixed-duration, hardware watchdog timer (WDT) is included in the 71M6403. This timer will reset the MPU if it is not refreshed periodically, and can be used to recover the MPU in situations where program control is lost.

The watchdog timer uses the RTC clock source as its time base and requires a reset under MPU program control at least every 1.3 (for CK38 = 38.4 kHz) seconds. When the WDT overflow occurs, the MPU is momentarily reset as if RESETZ were pulled low for half of a clock cycle. Thus, after 4100 cycles of CK38, the MPU program will be launched from address 00.

An I/O RAM register status bit, WD\_OVF (0x2002[2]), is set when WDT overflow occurs. This bit is powered by the VBAT pin and can be read by the MPU to determine if the part is initializing after a WDT overflow event or after a power up. After reading this bit, MPU firmware must clear WD\_OVF. The WD\_OVF bit is also cleared by the RESETZ pin.



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Because the watchdog timer uses CK38 as its clock reference, if the CK clock signal stops or slows down, *WD\_OVF* is set and a system reset will be performed when the CK clock resumes.

In normal operation, the WDT is reset by periodically writing a one to the *WDT\_RST* bit. The watchdog timer is also reset when WAKE=0 and, during development, when a 0x14 command is received from the ICE port.

There is no internal digital state that deactivates the WDT. For debug purposes, the WDT can be disabled by tying the V1 pin to V3P3. This also deactivates the power fault detection implemented with V1. Since there is no way in firmware to disable the WDT, it is guaranteed that whatever state the MPU might find itself in, it will be reset to a known state upon watchdog timer overflow.

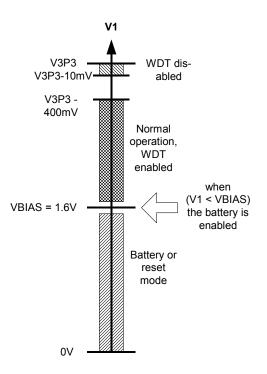


Figure 8: V1 Input Voltage Thresholds

#### Internal Voltages (VBIAS and V2P5)

The 71M6403 requires two supply voltages, V3P3A, for the analog section, and V3P3D, for the digital section. Both voltages can be tied together outside the chip. The internal supply voltage V2P5 is generated by an internal regulator from the 3.3V supplies.

VBIAS (1.6V) is generated internally and is used by the comparators V2 and INEUTRAL.



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#### Internal Clocks and Clock Dividers

All internal clocks are based on CK. This frequency is divided by 4 to generate 4.9152MHz, the frequency supplied to the ADC, the FIR filter (CKFIR), the CE DRAM and the clock generator. The clock generator provides two clocks, one for the MPU (CKMPU) and one for the CE (CKCE).

The MPU clock frequency is determined by the I/O RAM register  $MPU_DIV$  (0x2004[2:0]) and can be CE\*2<sup>-MPU\_DIV</sup> Hz where  $MPU_DIV$  varies from 0 to 7 ( $MPU_DIV$  is 0 on power-up). This makes the MPU clock scalable from 4.9152MHz down to 38.4kHz. The circuit also generates a 2x MPU clock for use by the emulator. This clock is not generated when the I/O RAM register *ECK\_DIS* (0x2005[5]) is asserted by the MPU.

### I<sup>2</sup>C Interface (EEPROM)

A dedicated 2-pin serial interface implements an  $I^2C$  driver that can be used to communicate with external EEPROM devices (type 24C1024). The  $I^2C$  interface can be enabled onto the DIO pins DIO4 (SCK) and DIO5 (SDA) by setting the I/O RAM register *DIO\_EEX* (0x2008[4]). The MPU communicates with the interface through two SFR registers: *EEDATA* (0x9E) and *EECTRL* (0x9F). If the MPU wishes to write a byte of data to the EEPROM, it places the data in *EEDATA* and then writes the 'Transmit' code to *EECTRL*. The write to *EECTRL* initiates the transmit sequence. By observing the *BUSY* bit in *EECTRL* the MPU can determine when the transmit operation is finished (i.e. when the *BUSY* bit transitions from 1 to 0). INT5 is also asserted when *BUSY* falls. The MPU can then check the *RX\_ACK* bit to see if the EEPROM acknowledged the transmission.

A byte is read by writing the 'Receive' command to *EECTRL* and waiting for *BUSY* to fall. Upon completion, the received data will appear in *EEDATA*. The serial transmit and receive clock is 78kHz during each transmission, and SCL is held in a high state until the next transmission. The bits in *EECTRL* are shown in Table 56. The EEPROM interface can also be operated by controlling the DIO4 and DIO5 pins directly.

| Status<br>Bit | Name     | Read/<br>Write | Polarity | D      | escription  |   |  |
|---------------|----------|----------------|----------|--------|---|---|--|
| 7             | ERROR    | R              | High     | Α      | sserted wh  | en an illegal command is received.  |  |
| 6             | BUSY     | R              | High     | Α      | sserted wh  | en serial data bus is busy.   |  |
| 5             | RX_ACK   | R              | High     | Ir     | ndicates that   | at the EEPROM sent an ACK bit.  |  |
| 4             | TX_ACK   | R              | High     | Ir     | Indicates when an ACK bit has been sent to the EEPROM |   |  |
|               |          |                |          |        | CMD   | Operation   |  |
|               |          |                |          |        | 0   | No-op. Applying the no-op command will stop the I <sup>2</sup> C clock (SCK, DIO4). Failure to issue the no-op command will keep the SCK signal toggling. |  |
|               |          |                |          |        | 2   | Receive a byte from EEPROM and send ACK.  |  |
| 3-0           | CMD[3:0] | W              | See CMD  |        | 3   | Transmit a byte to EEPROM   |  |
|               | 0        |                | Table    |        | 5   | Issue a 'STOP' sequence   |  |
|               |          |                |          |        | 6   | Receive the last byte from EEPROM and don't send ACK.   |  |
|               |          |                |          |        | 9   | Issue a 'START' sequence  |  |
|               |          |                |          | Others | No Operation, assert ERROR bit                        |   |  |

Note: Clock stretching and multi-master operation is not supported for the I<sup>2</sup>C interface.

#### Table 56: EECTRL Status Bits



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### **Test Ports**

**TMUXOUT Pin:** One out of 16 digital or 4 analog signals can be selected to be output on the TMUXOUT pin. The function of the multiplexer is controlled with the I/O RAM register *TMUX* (0x2000[3:0]), as shown in Table 57.

| TMUX[3:0] | Mode    | Function                          |
|-----------|---------|-----------------------------------|
| 0         | analog  | DGND                              |
| 1         | analog  | IBIAS                             |
| 2         | analog  | Reserved for production test      |
| 3         | analog  | VBIAS                             |
| 4         | digital | RTM (Real time output from CE)    |
| 5         | digital | Reserved for production test      |
| 6         | digital | V2_OK (Comparator 2 Output)       |
| 7         | digital | INEUTRAL_OK (Comparator 3 Output) |
| 8         | digital | RXD (from Optical interface)      |
| 9         | digital | MUX_SYNC                          |
| А         | digital | CK_10M                            |
| В         | digital | CK_MPU                            |
| С         |         | reserved for production test      |
| D         | digital | CK38                              |
| E         | digital | Reserved                          |
| F         | digital | Reserved                          |

Table 57: TMUX[3:0] Selections

**Emulator Port:** The emulator port, consisting of the pins E\_RST, E\_TCLK and E\_RXTX provides control of the MPU through an external in-circuit emulator. The E\_TBUS[3:0] pins, together with the E\_ISYNC/BRKRQ add trace capability to the emulator. The emulator port is compatible with the ADM51 emulators manufactured by Signum Systems.

The signals of the emulator port have weak pull-ups. Adding  $3k\Omega$  pull-up resistors on the PCB is recommended.

**Real-Time Monitor:** The RTM output of the CE is available as one of the digital multiplexer options. RTM data is read from the CE DRAM locations specified by I/O RAM registers *RTM0*, *RTM1*, *RTM2*, and *RTM3* after the rise of MUX\_SYNC. The RTM can be enabled and disabled with I/O RAM register *RTM\_EN*. The RTM output is clocked by CK/4. Each RTM word is clocked out in 35 cycles and contains a leading flag bit. Figure 9 in the System Timing Section illustrates the RTM output format. RTM is low when not in use.



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**Synchronous Serial Interface (SSI):** A high-speed serial interface with handshake capability is available to send a contiguous block of CE data to an external data logger or DSP. The block of data, configurable as to location and size, is sent starting 1 cycle of 32kHz before each CE code pass begins. If the block of data is big enough such that transmission has not completed when the code pass begins, it will complete during the CE code pass with no timing impact to the CE or the serial data. In this case, care must be taken that the transmitted data is not modified unexpectedly by the CE. The SSI interface is enabled by the *SSI\_EN* bit and consists of SCLK, SSDATA, and SFR as outputs and, optionally, SRDY as input. The interface is compatible with 16bit and 32bit processors. The operation of each pin is as follows:

SCLK is the serial clock. The clock can be 5MHz or 10MHz, as specified by the *SSI\_10M* bit. The *SSI\_CKGATE* bit controls whether SCLK runs continuously or is gated off when no SSI activity is occurring. If SCLK is gated, it will begin 3 cycles before SFR rises and will persist 3 cycles after the last data bit is output.

The pins used for the SSI are multiplexed with the LCD segment outputs, as shown in Table 58. Thus, the LCD should be disabled when the SSI is in use.

| SSI Signal | LCD Segment<br>Output Pin |
|------------|---------------------------|
| SCLK       | SEG3                      |
| SSDATA     | SEG4                      |
| SFR        | SEG5                      |
| SRDY       | SEG6                      |

Table 58: SSI Pin Assignment

SRDY is an optional handshake input that indicates that the DSP or data-logging device is ready to receive data. SRDY must be high to enable SFR to rise and initiate the transfer of the next field. It is expected that SRDY changes state on the rising edges of SCLK. If SRDY is not high when the SSI port is ready to transmit the next field, transmission will be delayed until it is. SRDY is ignored except at the beginning of a field transmission. If SRDY is not enabled (by *SSI\_RDYEN*), the SSI port will behave as if SRDY is always one.

SSDATA is the serial output data. SSDATA changes on the rising edge of SCLK and outputs the contents of a block of CE RAM words starting with address SSI\_STRT and ending with SSI\_END. The words are output MSB first.

The field size is set with the *SSI\_FSIZE* register: 0 entire data block, 1-8 bit fields, 2-16 bit fields, 3-32 bit fields. The polarity of the SFR pulse can be inverted with *SSI\_FPOL*. If SRDY does not delay it, the first SFR pulse in a frame will rise on the third SCLK after MUX\_SYNC (fourth SCLK if 10MHz). MUX\_SYNC can be used to synchronize the fields arriving at the data logger or DSP.



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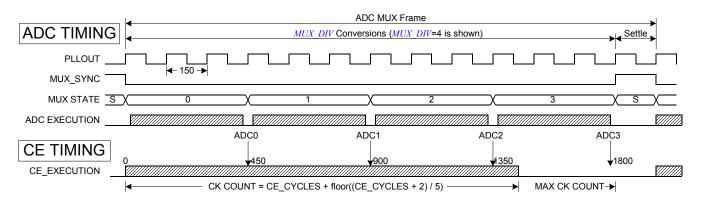
### FUNCTIONAL DESCRIPTION

### System Timing Summary

Figure 9 summarizes the timing relationships between the input MUX states. In this example,  $MUX_DIV=0$  (six mux states) and  $FIR_LEN = 0$  (2 PLLOUT cycles). Since FIR filter conversions require two or three PLLOUT cycles, the duration of each MUX cycle is  $1 + 2^*$  states defined by  $MUX_DIV$  if  $FIR_LEN = 0$ , and  $1 + 3^*$  states defined by  $MUX_DIV$  if  $FIR_LEN = 1$ . Followed by the conversions is a single PLLOUT cycle.

Each CE program pass begins when MUX\_SYNC falls. Depending on the length of the CE program, it may continue running until the end of the ADC5 conversion. CE opcodes are constructed to ensure that all CE code passes consume exactly the same number of cycles. The result of each ADC conversion is inserted into the CE DRAM when the conversion is complete. The CE code is designed to tolerate sudden changes in ADC data. The exact CK count when each ADC value is loaded into DRAM is shown in Figure 9.

Figure 9 also shows that the two serial data streams, RTM and SSI, begin transmitting at the beginning of MUX\_SYNC. RTM, consisting of 140 CK cycles, will always finish before the next code pass starts. The SSI port begins transmitting at the same time as RTM, but may significantly overrun the next code pass if a large block of data is required. Neither the CE nor the SSI port will be affected by this overlap.



### ADC, CE and SERIAL TIMING

NOTES:

1. ALL DIMENSIONS ARE 5MHZ CK COUNTS.

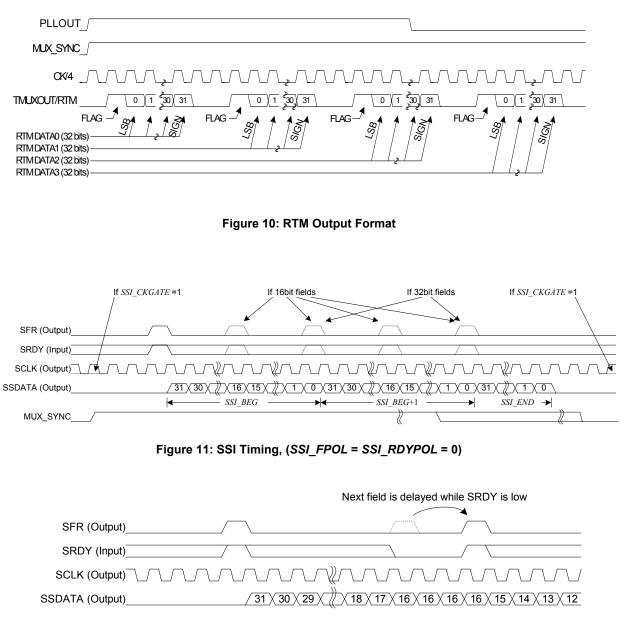
2. THE PRECISE FREQUENCY OF CK COUNTS IS 150\*CRYSTAL FREQUENCY = 4.9152MHz.

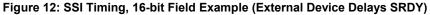
#### Figure 9: Timing Relationship between ADC MUX, CE, and Serial Transfers



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Figure 10, Figure 11, and Figure 12 show the RTM and SSI timing, respectively.





SFR is the framing pulse. Although CE words are always 32 bits, the SSI interface will frame the entire data block as a single field, as multiple 16-bit fields, or as multiple 32-bit fields. The SFR pulse is one SCLK clock cycle wide, changes state on the rising edge of SCLK and precedes the first bit of each field.



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### Data Flow

The data flow between CE and MPU is shown in Figure 13. In a typical application, the 32-bit compute engine (CE) sequentially processes the samples from the inputs on pins I0 through I5, performing calculations to measure the currents for circuit breaker operation. These measurements are then accessed by the MPU, processed further and output using the peripheral devices available to the MPU.

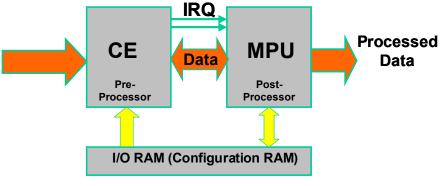


Figure 13: MPU/CE Data Flow

### **CE/MPU Communication**

Figure 14 shows the functional relationship between CE and MPU. The CE is controlled by the MPU via shared registers in the I/O RAM and by registers in the CE DRAM.

Figure 15 shows the sequence of events between CE and MPU upon reset or power-up. In a typical application, the sequence of events is as follows:

- 1) Upon power-up, the MPU initializes the hardware, including disabling the CE
- 2) The MPU loads the code for the CE into the CE PRAM
- 3) The MPU loads CE data into the CE DRAM.
- 4) The MPU starts the CE by setting the *CE\_EN* bit in the I/O RAM.
- 5) The CE then repetitively executes its code, generating results and storing them in the CE DRAM



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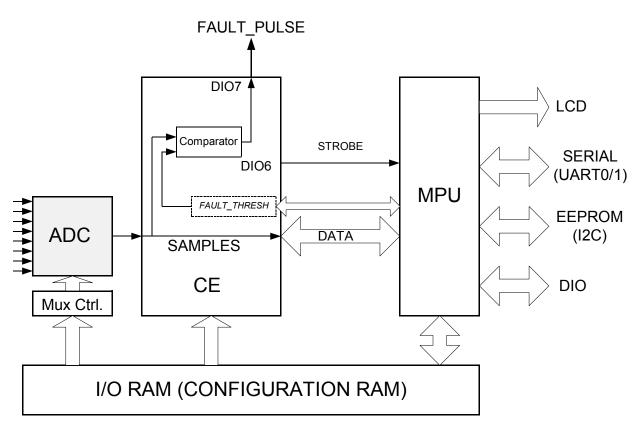


Figure 14: MPU/CE Communication (Functional)

The MPU will wait for the CE to signal that fresh data is ready (the XFER interrupt). It will read the data and perform additional processing.

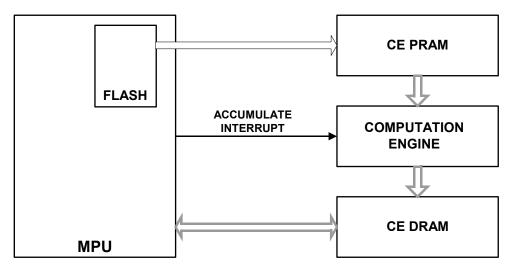


Figure 15: MPU/CE Communication (Processing Sequence)



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#### Fault, Reset, Power-Up

**Reset Mode:** When the RESETZ pin is pulled low, all digital activity in the chip stops while analog circuits are still active. Additionally, all I/O RAM bits are cleared..

When RESETZ goes high the MPU will begin executing its preboot and boot sequences from address 00. See the security section for more description of preboot and boot.

#### **Chopping Circuitry**

As explained in the hardware section, the bits of the I/O RAM register CHOP\_ENA[1:0] have to be toggled in between multiplexer cycles to achieve the desired elimination of DC offset.

The amplifier within the reference is auto-zeroed by means of an internal signal that is controlled by the *CHOP\_EN* bits. When this signal is HIGH, the connection of the amplifier inputs is reversed. This preserves the overall polarity of the amplifier gain but inverts the input offset. By alternately reversing the connection, the offset of the amplifier is averaged to zero. The function of the two bits of the *CHOP\_EN* register are described in Table 59.

| CHOP_EN[1] | CHOP_EN[0] | Function                      |  |  |
|------------|------------|-------------------------------|--|--|
| 0          | 0          | Toggle chop signal            |  |  |
| 0          | 1          | Reference connection positive |  |  |
| 1          | 0          | Reference connection reversed |  |  |
| 1          | 1          | Toggle chop signal            |  |  |

Table 59: CHOP\_EN Bits

For automatic chopping, the *CHOP\_EN* bits are set to either 00 or 11. In this mode, the polarity of the signals feeding the reference amplifier will be automatically toggled for each multiplexer cycle as shown in Figure 16. With an even number of multiplexer cycles in each accumulation interval, the number of cycles with positive reference connection will equal the number of cycles with reversed connection, and the offset for each sampled signal will be averaged to zero. This sequence is acceptable when only the primary signals (circuit breaker voltage, circuit breaker current) are of interest.

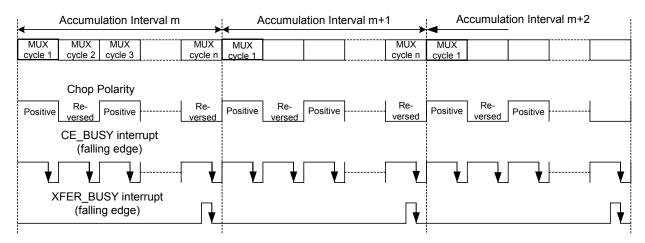


Figure 16: Chop Polarity w/ Automatic Chopping



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### **Program Security**

When enabled, the security feature limits the ICE to global flash erase operations only. All other ICE operations are blocked. This guarantees the security of the user's MPU and CE program code. Security is enabled by MPU code that is executed in a 32 cycle preboot interval before the primary boot sequence begins. Once security is enabled, the only way to disable it is to perform a global erase of the flash memory, followed by a chip reset. Global flash erase also clears the CE PRAM.

The first 32 cycles of the MPU boot code are called the preboot phase because during this phase the ICE is inhibited. A readonly status bit, *PREBOOT* (SFR 0xB2[7]), identifies these cycles to the MPU. Upon completion of the preboot sequence, the ICE can be enabled and is permitted to take control of the MPU.

SECURE (SFR 0xB2[6]), the security enable bit, is reset whenever the MPU is reset. Hardware associated with the bit permits only ones to be written to it. Thus, preboot code may set SECURE to enable the security feature but may not reset it. Once SECURE is set, the preboot code is protected and no external read of program code is possible.

Specifically, when SECURE is set:

- The ICE is limited to bulk flash erase only.
- Page zero of flash memory, the preferred location for the user's preboot code, may not be page-erased by either MPU or ICE. Page zero may only be erased with global flash erase. Note that global flash erase erases CE program RAM whether *SECURE* is set or not.
- Writes to page zero, whether by MPU or ICE, are inhibited.

Additionally, by setting the I/O RAM register *ECK\_DIS* to 1, the emulator clock is disabled, inhibiting access to the program with the emulator.



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### FIRMWARE INTERFACE

#### I/O RAM MAP – In Numerical Order

'Not Used' bits are blacked out and contain no memory and are read by the MPU as zero. *RESERVED* bits are in use and should not be changed.

| Name           | Addr | Bit 7        | Bit 6     | Bit 5        | Bit 4                 | Bit 3        | Bit 2        | Bit 1         | Bit 0   |  |
|----------------|------|--------------|-----------|--------------|-----------------------|--------------|--------------|---------------|---------|--|
| Configuration: |      |              |           |              |                       |              |              |               |         |  |
| CE0            | 2000 |              | $EQU^{1}$ |              | CE_EN                 |              | TMUX[3:0]    |               |         |  |
| CE1            | 2001 | PRE_SAI      | MPS[1:0]  |              |                       | SUM_CY       | CLES[5:0]    |               |         |  |
| CE2            | 2002 | MUX_L        | DIV[1:0]  | CHOP_I       | EN[1:0]               | RTM_EN       | WD_OVF       | EX_ZP8        | EX_XFR  |  |
| COMP0          | 2003 |              |           |              |                       | INT[1:0]     | (            | COMP_STAT[2:0 | 0]      |  |
| CONFIG0        | 2004 | VREF_CAL     |           | RESERVED     | Reserved <sup>2</sup> | VREF_DIS     |              | MPU_DIV       |         |  |
| CONFIG1        | 2005 | RESERVED     |           | ECK_DIS      | FIR_LEN               | ADC_DIS      | MUX_ALT      | FLASH66Z      | MUX_E   |  |
| VERSION        | 2006 |              |           |              |                       | ON[7:0]      |              |               |         |  |
|                |      |              |           |              | gital I/O:            |              |              |               |         |  |
| DIO0           | 2008 |              |           | OPT_TXDIS    | DIO_EEX               | DIO_STR      | DIO_FLT      |               |         |  |
| DIO1           | 2009 |              |           | DIO_R1[2:0]  |                       |              | DIO_R0[2:0]  |               |         |  |
| DIO2           | 200A |              |           | DIO_R3[2:0]  |                       |              | DIO_R2[2:0]  |               |         |  |
| DIO3           | 200B |              |           | DIO_R5[2:0]  |                       |              | DIO_R4[2:0]  |               |         |  |
| DIO4           | 200C |              |           | DIO_R7[2:0]  |                       |              | DIO_R6[2:0]  |               |         |  |
| DIO5           | 200D |              |           | DIO_R9[2:0]  |                       |              |              | DIO_R8[2:0]   |         |  |
| DIO6           | 200E |              |           | DIO_R11[2:0] |                       |              | DIO_R10[2:0] |               |         |  |
|                |      |              |           | LCD Dis      | play Interfa          | ce:          |              |               |         |  |
| LCDX           | 2020 | $LCD\_BSTEN$ |           |              |                       |              | LCD_NUM[4:0  | 1             |         |  |
| LCDY           | 2021 |              |           | LCD_EN       | L                     | .CD_MODE[2:0 | <i>)]</i>    | LCD_C         | LK[1:0] |  |
| LCDZ           | 2022 |              |           |              |                       |              | LCD_FS[4:0]  |               |         |  |
| LCD0           | 2030 |              |           |              |                       |              | LCD_SI       | EG0[3:0]      |         |  |
| LCD1           | 2031 |              |           |              |                       |              | LCD_SI       | EG1[3:0]      |         |  |
| LCD2           | 2032 |              |           |              | LCD_SEG2[3:0]         |              |              |               |         |  |
| LCD3           | 2033 |              |           |              |                       |              | LCD_SI       | EG3[3:0]      |         |  |
|                |      |              |           |              |                       |              |              |               |         |  |
| LCD39          | 2057 |              |           |              |                       |              | LCD_SE       | G39[3:0]      |         |  |
| LCD40          | 2058 |              |           |              |                       |              | LCD_SE       | G40[3:0]      |         |  |
| LCD41          | 2059 |              |           |              |                       |              | LCD_SE       | G41[3:0]      |         |  |

Note 1: Set EQU = 101.

Note 2: Set bit 2004:4 to 0.



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|                               | RTM Probes: |        |                  |            |                 |          |           |            |  |  |  |  |
|-------------------------------|-------------|--------|------------------|------------|-----------------|----------|-----------|------------|--|--|--|--|
| RTM0                          | 2060        |        | <i>RTM0[7:0]</i> |            |                 |          |           |            |  |  |  |  |
| RTM1                          | 2061        |        |                  |            | RTM1[7:0]       |          |           |            |  |  |  |  |
| RTM2                          | 2062        |        | <i>RTM2[7:0]</i> |            |                 |          |           |            |  |  |  |  |
| RTM3                          | 2063        |        | RTM3[7:0]        |            |                 |          |           |            |  |  |  |  |
| Synchronous Serial Interface: |             |        |                  |            |                 |          |           |            |  |  |  |  |
| SSI                           | 2070        | SSI_EN | SSI_10M          | SSI_CKGATE | SSI_FSIZE[1:0]  | SSI_FPOL | SSI_RDYEN | SSI_RDYPOL |  |  |  |  |
| SSI_BEG                       | 2071        |        |                  |            | SSI_BEG[7:0]    |          |           |            |  |  |  |  |
| SSI_END                       | 2072        |        |                  |            | SSI_END[7:0]    |          |           |            |  |  |  |  |
|                               |             |        |                  | Fuse Selec | tion Registers: |          |           |            |  |  |  |  |
| TRIMSEL                       | 20FD        |        |                  |            | TRIMSEL[7:0]    |          |           |            |  |  |  |  |
| TRIM                          | 20FF        |        |                  |            | TRIM[7:0]       |          |           |            |  |  |  |  |

#### SFR MAP (SFRs Specific to TERIDIAN 80515) – In Numerical Order

'Not Used' bits are blacked out and contain no memory and are read by the MPU as zero. *RESERVED* bits are in use and should not be changed. This table lists only the SFR registers that are not generic 8051 SFR registers.

| Name    | SFR<br>Addr  | Bit 7   | Bit 6                      | Bit 5      | Bit 4       | Bit 3     | Bit 2       | Bit 1     | Bit 0    |  |  |  |  |
|---------|--------------|---------|----------------------------|------------|-------------|-----------|-------------|-----------|----------|--|--|--|--|
|         | Digital I/O: |         |                            |            |             |           |             |           |          |  |  |  |  |
| P0      | 80           |         | <i>DIO_0[7:0]</i> (Port 0) |            |             |           |             |           |          |  |  |  |  |
| DIR0    | A2           |         |                            |            |             |           | DIO_DIR0[7: | -0]       |          |  |  |  |  |
| P1      | 90           |         |                            |            |             |           | DIO_1[7:0]  | / (Port ' | 1)       |  |  |  |  |
| DIR1    | 91           |         | DIO_DIR1[7:0]              |            |             |           |             |           |          |  |  |  |  |
| P2      | A0           |         | DIO_2[5:0] (Port 2)        |            |             |           |             |           |          |  |  |  |  |
| DIR2    | A1           |         | DIO_DIR2[5:0]              |            |             |           |             |           |          |  |  |  |  |
|         |              |         |                            | Interrupts | s and WD Ti | mer:      |             |           |          |  |  |  |  |
| INTBITS | F8           |         | INT6                       | INT5       | INT4        | INT3      | INT2        | INT1      | INT0     |  |  |  |  |
| WDI     | E8           | WD_RST  |                            |            |             |           |             | IE_ZP8    | IE_XFER  |  |  |  |  |
|         |              |         |                            |            | Flash:      |           |             |           |          |  |  |  |  |
| ERASE   | 94           |         |                            |            | FLSH_E      | RASE[7:0] |             |           |          |  |  |  |  |
| FLSHCTL | B2           | PREBOOT | SECURE                     |            |             |           |             | FLSH_MEEN | FLSH_PWE |  |  |  |  |
| PGADR   | B7           |         | <u>.</u>                   | F          | LSH_PGADR[6 | :0]       |             |           |          |  |  |  |  |
|         |              |         |                            | Seria      | al EEPROM:  |           |             |           |          |  |  |  |  |
| EEDATA  | 9E           |         | EEDATA[7:0]                |            |             |           |             |           |          |  |  |  |  |
| EECTRL  | 9F           |         |                            |            | EECT        | RL[7:0]   |             |           |          |  |  |  |  |



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#### I/O RAM (Configuration RAM) – Alphabetical Order

Many functions of the chip can be controlled via the I/O RAM (Configuration RAM). The CE will also take some of its parameters from the I/O RAM.

Bits with a W (write) direction are written by the MPU into I/O RAM. Typically, they are initially stored in flash memory and copied to the I/O RAM by the MPU. Some of the more frequently programmed bits are mapped to the MPU SFR memory space. The remaining bits are mapped to 2xxx. Bits with R (read) direction can only be read by the MPU. **On power up, all bits are cleared to zero unless otherwise stated.** Generic SFR registers are not listed.

| Name  | Location<br>[Bit(s)]  | Dir                             | Description   |   |                 |  |  |
|---|---|---------------------------------|---|---|-----------------|--|--|
| ADC_DIS   | 2005[3]   | R/W                             | Disables ADO  | C and removes bias current  |                 |  |  |
| CE_EN   | 2000[4]   | R/W                             | CE enable.  |   |                 |  |  |
| CHOP_EN[1:0]  | 2002[5:4]   | R/W                             | Chop enable   | for the reference band gap circuit.   |                 |  |  |
|   |   |                                 | 00: enabled   | 01: disabled 10: disabled 11: enabled   |                 |  |  |
| RESERVED  | 2004[5]   | R/W                             | Must be 0.  |   |                 |  |  |
| COMP_INT[1:0]   | 2003[4:3]   | R/W                             | Two bits establishing whether a comparator state change should create MPU interrupts. 1: interrupt, 0: no interrupt. If 11, the comparator outputs are XOR'ed.<br>Bit0 = comp2, Bit1 = comp3  |   |                 |  |  |
| COMP_STAT[2:0]  | 2003[2:0]   | R                               | Three bits co   | ntaining comparator output status.  |                 |  |  |
|   |   |                                 | Bit0 = comp1, Bit1 = comp2, Bit2 = comp3  |   |                 |  |  |
| DIO_R0[2:0]<br>DIO_R1[2:0]<br>DIO_R2[2:0]<br>DIO_R3[2:0]<br>DIO_R4[2:0] | 2009[2:0]<br>2009[6:4]<br>200A[2:0]<br>200A[6:4]<br>200B[2:0] | R/W<br>R/W<br>R/W<br>R/W<br>R/W | Connects dedicated I/O pins 0 to 11 to selectable internal resources. If<br>more than one input is connected to the same resource, the 'Multiple'<br>column below specifies how they are combined. See Software User's<br>Guide for details). |   |                 |  |  |
| DIO_R5[2:0]   | 200B[2:0]<br>200B[6:4]  | R/W                             | DIO_GP  | Resource  | Multiple        |  |  |
| DIO_R6[2:0]   | 200C[2:0]   | R/W                             | 0   | NONE  |                 |  |  |
| DIO_R7[2:0]   | 200C[6:4]   | R/W                             | 1   | Reserved  | OR              |  |  |
| DIO_R8[2:0]   | 200D[2:0]   | R/W                             | 2   | T0 (counter0 clock)   | OR              |  |  |
| DIO_R9[2:0]<br>DIO_R10[2:0]   | 200D[6:4]<br>200E[2:0]  | R/W<br>R/W                      | 3   | T1 (counter1 clock)   | OR              |  |  |
| DIO_R11[2:0]  | 200E[2:0]<br>200E[6:4]  | R/W                             | 4   | High priority I/O interrupt (int0 rising)   | OR              |  |  |
| 010_111[2.0]  | 2000[0.4]   | 1.7.4.4                         | 5   | Low priority I/O interrupt (int1 rising)  | OR              |  |  |
|   |   |                                 | 7   | High priority I/O interrupt (int0 falling)<br>Low priority I/O interrupt (int1 falling) | OR<br>OR        |  |  |
| DIO_DIR0[7:0]   | SFR A2  | R/W                             | Programs the direction of DIO pins 7 through 0. 1 indicates output.<br>Ignored if the pin is not configured as I/O. See <i>DIO_EEX</i> for special option for DIO4 and DIO5.  |   |                 |  |  |
| DIO_DIR1[7:0]   | SFR 91  | R/W                             | Programs the direction of DIO pins 15 through 8. 1 indicates output.<br>Ignored if the pin is not configured as I/O.  |   |                 |  |  |
| DIO_DIR2[5:0]   | SFR A1[5:0]   | R/W                             |   | direction of DIO pins 21 through 16. 1 inc<br>pin is not configured as I/O.             | dicates output. |  |  |



| DIO_0[7:0]SFR 80R/WPort 0The value on the DIO pins. Pins configureDIO_1[7:0]SFR 90R/WPort 1zero. When written, changes data on pinsDIO_2[5:0]SFR A0[5:0]R/WPort 2puts. Pins configured as LCD or input will | ed as LCD will read  |
|---|----------------------|
|   | s configured as out- |
| DIO_FLT         2008[2]         R/W         Causes FAULT_PULSE to be output on DIO7, if DIO output. LCD_NUM must be less than 15. Initialize L  |                      |
| DIO_STR         2008[3]         R/W         Causes STROBE to be output on DIO6, if DIO6 is concerned by LCD_NUM must be less than 16. Initialize DIO_STM  |                      |
| DIO_EEX       2008[4]       R/W       When set, converts DIO4 and DIO5 to interface with EEPROM. DIO4 becomes SCK and DIO5 becomes LCD_NUM must be less than 18.  |                      |
| EEDATA[7:0]         SFR 9E         R/W         Serial EEPROM interface data   |                      |
| EECTRL[7:0]         SFR 9F         R/W         Serial EEPROM interface control  |                      |
| ECK_DIS 2005[5] R/W Emulator clock disable. When one, the emulator clock  | ck is disabled.      |
| EX_XFR         2002[0]         R/W         Interrupt enable bits. These bits enable the XFER_E  |                      |
| EX_ZP82002[1]interrupts to the MPU. Note that if either interrupt is<br>in the 80515 must also be set.  | to be enabled, EX6   |
| FIR_LEN         2005[4]         R/W         The length of the ADC decimation FIR filter.  |                      |
| 1: 22 ADC bits/3 PLLOUT cycles (384 CKFIR cycles<br>0: 21 ADC bits/2 PLLOUT cycles (288 CKFIR cycles  |                      |
| FLASH66Z         2005[1]         R/W         Should be set to 1 to minimize supply current.   |                      |
| FLSH_ERASE SFR 94 W Flash Erase Initiate  |                      |
| FLSH_ERASE is used to initiate either the Flash Ma<br>the Flash Page Erase cycle. Specific patterns are ex<br>FLSH_ERASE in order to initiate the appropriate Era   | kpected for          |
| (default = 0x00).   |                      |
| 0x55 – Initiate Flash Page Erase cycle. Must be pre<br>FLSH_PGADR @ SFR 0xB7.   | ceded by a write to  |
| 0xAA – Initiate Flash Mass Erase cycle. Must be pre<br>FLSH_MEEN @ SFR 0xB2 and the debug<br>enabled.   |                      |
| Any other pattern written to FLSH_ERASE will have   | no effect.           |
| FLSH_MEEN         SFR B2[1]         W         Mass Erase Enable   |                      |
| 0 – Mass Erase disabled (default).  |                      |
| 1 – Mass Erase enabled.   |                      |
| Must be re-written for each new Mass Erase cycl   | le.                  |
| FLSH_PGADR         SFR B7[7:1]         W         Flash Page Erase Address   |                      |
| FLSH_PGADR[6:0] – Flash Page Address (page 0 t<br>erased during the Page Erase cycle. (default = 0x00   |                      |
| Must be re-written for each new Page Erase cycl   | le.                  |



| FLSH_PWE      | SFR B2[0]   | R/W | Program Write Enable  |  |  |
|---------------|-------------|-----|---|--|--|
|               |             |     | 0 – MOVX commands refer to XRAM Space, normal operation (default).  |  |  |
|               |             |     | 1 – MOVX @DPTR, A moves A to Program Space (Flash) @ DPTR.  |  |  |
|               |             |     | This bit is automatically reset after each byte written to flash. Writes to this bit are inhibited when interrupts are enabled.   |  |  |
| Reserved      | SFR E8[0]   | R/W | Interrupt flags. These flags are part of the WDI SFR register and mo-   |  |  |
| IE_ZP8        | SFR E8[1]   |     | nitor the ZP8 interrupt. The flags are set by hardware and must be cleared by the interrupt handler.  |  |  |
| INTBITS       | SFR F8[6:0] | R   | Interrupt inputs. The MPU may read these bits to see the input to external interrupts INT0, INT1, up to INT6. These bits do not have any memory and are primarily intended for debug use. |  |  |
| LCD_BSTEN     | 2020[7]     | R/W | Enables the LCD voltage boost circuit.  |  |  |
| LCD_CLK[1:0]  | 2021[1:0]   | R/W | Sets the LCD clock frequency for COM/SEG pins (not the frame rate)<br>Note: f <sub>w</sub> = CKFIR/128  |  |  |
|               |             |     | 00: $f_w/2^9$ , 01: $f_w/2^8$ , 10: $f_w/2^7$ , 11: $f_w/2^6$   |  |  |
| LCD_EN        | 2021[5]     | R/W | Enables the LCD display. When disabled, VLC2, VLC1, and VLC0 are ground as are the COM and SEG outputs.   |  |  |
| LCD_FS[4:0]   | 2022[4:0]   | R/W | Controls the LCD full scale voltage, VLC2:  |  |  |
|               |             |     | $VLC2 = VLCD \cdot (0.7 + 0.3 \frac{LCD\_FS}{31})$  |  |  |
| LCD_MODE[2:0] | 2021[4:2]   | R/W | The LCD bias mode.  |  |  |
|               |             |     | 000: 4 states, 1/3 bias   |  |  |
|               |             |     | 001: 3 states, 1/3 bias   |  |  |
|               |             |     | 010: 2 states, ½ bias   |  |  |
|               |             |     | 011: 3 states, ½ bias   |  |  |
|               |             |     | 100: static display   |  |  |



| LCD_NUM[4:0]                        | 2020[4:0]                  | R/W | Number of dual-purpose LCD/DIO pins to be configured as LCD. This number can be between 0 and 18. The first dual-purpose pin to be used as LCD is SEG41/DIO21. If <i>LCD_NUM</i> = 2, SEG41 and SEG 40 will be configured as LCD. The remaining SEG39 to SEG24 will be configured as DIO19 to DIO4. |   |   |  |  |
|-------------------------------------|----------------------------|-----|---|---|---|--|--|
|                                     |                            |     |   | SEG   | DIO   |  |  |
|                                     |                            |     | 0   | None  | DIO4-21   |  |  |
|                                     |                            |     | 1   | SEG41   | DIO4-20   |  |  |
|                                     |                            |     | 2   | SEG40-41  | DIO4-19   |  |  |
|                                     |                            |     | 3   | SEG39-41  | DIO4-18   |  |  |
|                                     |                            |     | 4   | SEG38-41  | DIO4-17   |  |  |
|                                     |                            |     | 5   | SEG37-41  | DIO4-16   |  |  |
|                                     |                            |     | 6   | SEG36-41  | DIO4-15   |  |  |
|                                     |                            |     | 7   | SEG35-41  | DIO4-14   |  |  |
|                                     |                            |     | 8   | SEG34-41  | DIO4-13   |  |  |
|                                     |                            |     | 9   | SEG33-41  | DIO4-12   |  |  |
|                                     |                            |     | 10  | SEG32-41  | DIO4-11   |  |  |
|                                     |                            |     | 11  | SEG31-41  | DIO4-10   |  |  |
|                                     |                            |     | 12  | SEG30-41  | DIO4-9  |  |  |
|                                     |                            |     | 13  | SEG29-41  | DIO4-8  |  |  |
|                                     |                            |     | 14  | SEG28-41  | DIO4-7  |  |  |
|                                     |                            |     | 15  | SEG27-41  | DIO4-6  |  |  |
|                                     |                            |     | 16  | SEG26-41  | DIO4-5  |  |  |
|                                     |                            |     | 17  | SEG25-41  | DIO4  |  |  |
|                                     |                            |     | 18  | SEG24-41  | None  |  |  |
| LCD_SEG0[3:0]<br><br>LCD_SEG41[3:0] | 2030[3:0]<br><br>2059[3:0] | R/W |   | each segment. In each                               | s information for from 1 to 4<br>word, bit 0 corresponds to |  |  |
| MPU_DIV[2:0]                        | 2004[2:0]                  | R/W |   | divider (from CKCE). The nout risk of losing contro | nese bits may be programmed<br>l.                           |  |  |
|                                     |                            |     | 000 - C   | KCE, 001 - CKCE/2,                                  | ., 111 - CKCE/2 <sup>7</sup>                                |  |  |
|                                     |                            |     | MPU DIV is 000  |   |   |  |  |
| MUX_ALT                             | 2005[2]                    | R/W | The MPU asser   | ts this bit when it wishes                          | s the MUX to perform ADC<br>s.                              |  |  |
| MUX_DIV[1:0]                        | 2002[7:6]                  | R/W | conversions on an alternate set of inputs.<br>The number of states in the input multiplexer.<br>00 - 6 states (I0-I5)<br>01 - 4 states (I0-I3)<br>10 - 3 states (I0-I2)<br>11 - 2 states (I0-I1)  |   |   |  |  |
| MUX_E                               | 2005[0]                    | R/W | -   |   | rts SEG7 into a MUX_SYNC                                    |  |  |



|  | 0000153                      | <b>D</b> 3 4 4 |  |
|--|------------------------------|----------------|--|
| OPT_TXDIS  | 2008[5]                      | R/W            | Tristates the OPT_TX output.   |
| PREBOOT  | SFR B2[7]                    | R              | Indicates that the preboot sequence is active.   |
| Reserved[1:0]                                    | 2001[7:6]                    | R/W            | Reserved   |
| RTM_EN   | 2002[3]                      | R/W            | Real Time Monitor enable. When '0', the RTM output is low. This bit enables the two wire version of RTM $$   |
| RTM0[7:0]<br>RTM1[7:0]<br>RTM2[7:0]<br>RTM3[7:0] | 2060<br>2061<br>2062<br>2063 | R/W            | Four RTM probes. Before each CE code pass, the values of these registers are serially output on the RTM pin. The <i>RTM</i> registers are ignored when <i>RTM_EN</i> =0.   |
| SECURE   | SFR B2[6]                    | R/W            | Enables security provisions that prevent external reading of flash<br>memory and CE program RAM. This bit is reset on chip reset and may<br>only be set. Attempts to write zero are ignored.   |
| SSI_EN   | 2070[7]                      | R/W            | Enables the Synchronous Serial Interface (SSI) on SEG3, SEG4, and SEG5 pins. If <i>SSI_RDYEN</i> is set, SEG6 is enabled also. The pins take on the new functions SCLK, SSDATA, SFR, and SRDY, respectively. When <i>SSI_EN</i> is high and <i>LCD_EN</i> is low, these pins are converted to the SSI function, regardless of <i>LCDEN</i> and <i>LCD_NUM</i> . For proper LCD operation, <i>SSI_EN</i> must not be high when <i>LCD_EN</i> is high. |
| SSI_10M  | 2070[6]                      | R/W            | SSI clock speed: 0: 5MHz, 1: 10MHz   |
| SSI_CKGATE                                       | 2070[5]                      | R/W            | SSI gated clock enable. When low, the SCLK is continuous. When high, the clock is held low when data is not being transferred.   |
| SSI_FSIZE[1:0]                                   | 2070[4:3]                    | R/W            | <ul><li>SSI frame pulse format:</li><li>0: once at beginning of SSI sequence (whole block of data),</li><li>1: every 8 bits, 2: every 16 bits, 3: every 32 bits.</li></ul>   |
| SSI_FPOL   | 2070[2]                      | R/W            | SFR pulse polarity: 0: positive, 1: negative   |
| SSI_RDYEN  | 2070[1]                      | R/W            | SRDY enable. If <i>SSI_RDYEN</i> and <i>SSI_EN</i> are high, the SEG6 pin is configured as SRDY. Otherwise, it is an LCD driver.   |
| SSI_RDYPOL                                       | 2070[0]                      | R/W            | SRDY polarity: 0: positive, 1: negative  |
| SSI_BEG[7:0]                                     | 2071[7:0]                    | R/W            | The beginning and ending address of the transfer region of the CE  |
| SSI_END[7:0]                                     | 2072[7:0]                    |                | data memory. If the SSI is enabled, a block of words starting with <i>SSI_BEG</i> and ending with <i>SSI_END</i> will be sent. <i>SSI_END</i> must be larger than <i>SSI_BEG</i> . The maximum number of output words is limited by the number of SSI clocks in a CE code pass—see <i>FIR_LEN</i> , <i>MUX_DIV</i> , and <i>SSI_10M</i> .  |
| Reserved   | 2001[5:0]                    | R/W            | Reserved   |



| TMUNDON      | 2000[2:0] | R/W   | Selecte one of 16 inputs for TMUXOUT  |  |  |  |
|--------------|-----------|-------|---|--|--|--|
| TMUX[3:0]    | 2000[3:0] | K/ VV | Selects one of 16 inputs for TMUXOUT.   |  |  |  |
|              |           |       | 0 – DGND (analog)   |  |  |  |
|              |           |       | 1 – IBIAS (analog)  |  |  |  |
|              |           |       | 2 – Reserved for production test  |  |  |  |
|              |           |       | 3 – VBIAS (analog)  |  |  |  |
|              |           |       | 4 – RTM (Real time output from CE)  |  |  |  |
|              |           |       | 5 – Reserved for production test  |  |  |  |
|              |           |       | 6 – V2_OK (Comparator 2 Output)   |  |  |  |
|              |           |       | 7 – INEUTRAL_OK (Comparator 3 Output)   |  |  |  |
|              |           |       | 8 – RXD (from Optical interface)  |  |  |  |
|              |           |       | 9 – MUX_SYNC (from MUX_CTRL)  |  |  |  |
|              |           |       | A – CK_10M  |  |  |  |
|              |           |       | B – CK_MPU  |  |  |  |
|              |           |       | C – reserved for production test  |  |  |  |
|              |           |       | D – CK38  |  |  |  |
|              |           |       | E – Reserved  |  |  |  |
|              |           |       | F – Reserved  |  |  |  |
| RESERVED     | 2005[7]   | R/W   | Must be zero.   |  |  |  |
| TRIMSEL      | 20FD      | W     | Selects the temperature trim fuse to be read with the <i>TRIM</i> register ( <i>TRIMM</i> [2:0]: 4, <i>TRIMBGA</i> : 5, <i>TRIMBGB</i> : 6) |  |  |  |
| TRIM         | 20FF      | R     | Contains <i>TRIMBGA</i> , <i>TRIMBGB</i> , or <i>TRIMM</i> [2:0] depending on the value written to <i>TRIMSEL</i> .                         |  |  |  |
| VERSION[7:0] | 2006      | R     | The silicon revision number. This data sheet does not apply to revisions preceding revision 000 0100.                                       |  |  |  |
| VREF_CAL     | 2004[7]   | R/W   | Enables VREF out to the VREF pin. This feature is disabled when<br>VREF_DIS=1.  |  |  |  |
| VREF_DIS     | 2004[3]   | R/W   | Disables the internal voltage reference.  |  |  |  |



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#### CE Program and Environment

### CE Program

The CE program is supplied by TERIDIAN as a data image that can be merged with the MPU operational code for circuit breaker applications. Typically, the CE program covers most applications and does not need to be modified. Proper operation of the CE requires the following environment variables to be set as follows:  $FIR\_LEN = 0$ ,  $MUX\_DIV = 0$  and EQU = 101.

### Formats

All CE words are 4 bytes. Unless specified otherwise, they are in 32-bit two's complement (-1 = 0xFFFFFFF). 'Calibration' parameters are defined in flash memory (or external EEPROM) and must be copied to CE memory by the MPU before enabling the CE. 'Internal' variables are used in internal CE calculations. 'Input' variables allow the MPU to control the behavior of the CE code. 'Output' variables are outputs of the CE calculations. The corresponding MPU address for the most significant byte is given by  $0x1000 + 4 \times CE_address$  and  $0x1003 + 4 \times CE_address$  for the least significant byte.

### Constants

Constants used in the CE Data Memory tables are:

- Sampling frequency: F<sub>S</sub> = 32768Hz/13 = 2520.62Hz.
- *IMAX* is the external rms current corresponding to 250mV pk at the inputs I0 through I5.

The system constant *IMAX* is used by the MPU to convert internal digital quantities (as used by the CE) to external, i.e. current quantities. Their values are determined by the scaling of the current sensors used in an actual circuit breaker. The LSB values used in this document relate digital quantities at the CE or MPU interface to external circuit breaker input quantities.

### Environment

Before starting the CE using the CE\_EN bit, the MPU has to establish the proper environment for the CE by implementing the following steps:

- Loading the image for the CE code into CE PRAM.
- Loading the CE data into CE DRAM.
- *FIR\_LEN* = 0 (two cycles per conversion)
- *MUX\_DIV* = 0 (6 conversions per mux cycle)
- *EQU* = 101

During operation, the MPU is in charge of controlling the multiplexer cycles. For example, by inserting an alternate multiplexer sequence at regular intervals using *MUX\_ALT* to enable temperature measurement. The polarity of CHOP must be altered for each sample. It must also alternate for each alternate multiplexer reading.



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#### **CE Calculations**

The CE performs the precision computations necessary to accurately measure and detect current. The compute engine firmware implements the following:

- 1. Supports 6 current sensing channels
- 2. Each channel individually configurable for Current Transformer or Rogowski coil
- 3. Each channel individually configurable for x8 gain for low signal sensors (MAX out < 20 mV)
- 4. Channel I4 configurable for Ground Fault current with fundamental frequency band pass filter or the vectorial sum of first current input channel data (Insqsum)
- 5. Channel I5 includes a band pass filter to process the components of fundamental frequency of operation only
- 6. Programmable accumulation interval generates interrupt on DIO6 for data collection
- 7. Programmable FAULT\_THRESH register sets over current detection to generate FAULT\_PULSE on DIO7
- 8. Individual channel calibration coefficients to adjust the gain for desired accuracy

#### CE RAM Locations

#### **CE Front End Data (Raw Data)**

Access to the raw data provided by the AFE is possible by reading addresses 0 through 7, as listed below. The table also shows the Configuration Register location for each input channel.

| Address (HEX) | Input<br>Channel | Configuration<br>Register | Description   |
|---------------|------------------|---------------------------|---|
| 0x00          | 10               | 0x28                      | Current input 0   |
| 0x01          | l1               | 0x29                      | Current input 1   |
| 0x02          | 12               | 0x2A                      | Current input 2   |
| 0x03          | 13               | 0x2B                      | Current input 3   |
| 0x04          | 14               | 0x2C                      | Current input 4   |
| 0x05          | 15               | 0x2D                      | Current input 5   |
| 0x06          | TEMP             |                           | Temperature   |
| 0x07          | INEUTRAL         |                           | INEUTRAL monitor/compara-<br>tor input to power fault block |



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### Input Configuration

The input sensor type and its gain can be set for each current input using the configuration registers 0x28 thru 0x2D, as listed in the table below (bits labeled "X" are "don't care"):

|         |         |   | Bit |   |   |   |       |        |      |  |
|---------|---------|---|-----|---|---|---|-------|--------|------|--|
| Address | Channel | 7 | 6   | 5 | 4 | 3 | 2     | 1      | 0    |  |
| 0x28    | 10      | Х | Х   | Х | Х | Х | Х     | CT/ROG | GAIN |  |
| 0x29    | l1      | Х | Х   | Х | Х | Х | Х     | CT/ROG | GAIN |  |
| 0x2A    | 12      | Х | Х   | Х | Х | Х | Х     | CT/ROG | GAIN |  |
| 0x2B    | 13      | Х | Х   | Х | Х | Х | Х     | CT/ROG | GAIN |  |
| 0x2C    | 14      | Х | Х   | Х | Х | Х | I4SUM | CT/ROG | GAIN |  |
| 0x2D    | 15      | Х | Х   | Х | Х | Х | Х     | CT/ROG | GAIN |  |

By setting bit 0 = 1, a gain of 8 is applied to the input raw signal associated with the configuration register. When bit 1 is set to 1, the compute engine will process the input signal as a signal from a Rogowski coil sensor.

**Example:** When 0x03 is written to the configuration register at address 0x29, the I1\_RAW input signal is processed with a gain of 8 and is also integrated, assuming that it is generated by a Rogowski coil current sensor.

The processing for I4 can be selected to implement either a regular current input (I4SUM = 0) or to calculate a vectorial sum of inputs I0, I1, I2, and I3 (I4SUM = 1). When I4SUM is set to 1, all other configuration bits for I4 are ignored. Likewise, the CE ignores the I4SUM bit for all channels other than I4.

The *NB* (narrow-band) register (0x2E) allows control of the band-pass filtering for fundamental components in the channels I4 and I5. When *NB* is set to 1, the narrow-band filter is activated:

| Bit      | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0  |
|----------|---|---|---|---|---|---|---|----|
| Function | Х | Х | Х | Х | Х | X | X | NB |

#### Accumulation Strobe Output

Since circuit breaker applications tend to have very short accumulation intervals, the CE supports signaling the end of the accumulation interval by a strobe on the DIO6 pin.

This can be used for generating a hardware interrupt. If a hardware interrupt is desired, DIO6 should be configured as an output, and the associated *DIO\_Rx* register in I/O RAM should be used to associate an interrupt source with the pin.

The CE generates a low-going strobe of  $397\mu$ s at the end of each accumulation interval. The control register for the accumulation interval is  $STR\_CNT$  (address 0x31). This register has a resolution of 397 microseconds. The accumulation interval is controlled by  $STR\_CNT$  as follows:

Accumulation interval = (STR\_CNT + 1) \* 397µs

**Example:** When *STR\_CNT* is set to (decimal) 12, the accumulation interval will be 5.1 ms.

The processed data is available in the following registers.



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#### **Processed Current Data**

Processed current data is available in CE addresses 0x4A through 0x4F, as listed below:

| Output<br>Register | CE Address | Description   |
|--------------------|------------|---|
| I0SQSUM_X          | 0x4A       | LSB = $(IMAX/In8)^2 * 3.3335*10^{-8} A^2 peak$                              |
| I1SQSUM_X          | 0x4B       | LSB = (IMAX/In8) <sup>2</sup> * 3.3335*10 <sup>-8</sup> A <sup>2</sup> Peak |
| I2SQSUM_X          | 0x4C       | LSB = (IMAX/In8) <sup>2</sup> * 3.3335*10 <sup>-8</sup> A <sup>2</sup> Peak |
| I3SQSUM_X          | 0x4D       | LSB = (IMAX/In8) <sup>2</sup> * 3.3335*10 <sup>-8</sup> A <sup>2</sup> Peak |
| I4SQSUM_X          | 0x4E       | LSB = (IMAX/In8) <sup>2</sup> * 3.3335*10 <sup>-8</sup> A <sup>2</sup> Peak |
| I5SQSUM_X          | 0x4F       | LSB = (IMAX/In8) <sup>2</sup> * 3.3335*10 <sup>-8</sup> A <sup>2</sup> Peak |

The CE writes the output data into the I0SQSUM\_X, I1SQSUM\_X etc. registers at the end of each accumulation interval.

The values for IXSQSUM\_X are based on the formula:

$$IXSQSUM\_X = \sum_{0}^{STR\_CNT+1} IXSQ$$

### **Overcurrent Detection**

The main task in circuit breaker applications is to detect an over-current situation as quickly as possible and to apply the tripping procedures. The CE firmware has an integrated comparator function that helps to verify each measured sample with reference to the value stored in the *FAULT\_THRESH* register at address 0x2F. If a sample above the programmed *FAULT\_TRHESH* is encountered in one of the input signals 10, 11, 12 or 13, the FAULT\_PULSE is generated on the DIO7 pin. This pin should be configured by the MPU to be an output pin and should be internally set to generate an interrupt in order to initiate the necessary routines of the circuit breaker application firmware. The process for generating the FAULT\_PULSE from encountering a sample above the programmed threshold can be less than 400µs.

| CE Register  | CE Address | Description                                       |
|--------------|------------|---|
| FAULT_THRESH | 0x2F       | LSB = (IMAX/In8) * 5.5719*10 <sup>-9</sup> A peak |
| STR_CNT      | 0x31       | STROBE_PULSE =                                    |
|              |            | ( <i>STR_CNT</i> + 1) * 3.9673*10 <sup>-4</sup> s |



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### **CE** Calibration Parameters

The table below lists the parameters that are typically entered to effect calibration of circuit breaker accuracy.

| CE<br>Address | Name   | Default | Description  |
|---------------|--------|---------|--|
| 0x08          | CAL_I0 | 16384   |  |
| 0x09          | CAL_I1 | 16384   | These six constants control the gain of their respective channels. The nominal                                       |
| 0x0A          | CAL_I2 | 16384   | value for each parameter is $2^{14} = 16384$ . The gain of each channel is directly                                  |
| 0x0B          | CAL_I3 | 16384   | proportional to its calibration parameter. Thus, if the gain of a channel is 1% slow, CAL should be increased by 1%. |
| 0x0C          | CAL_I4 | 16384   | SIOW, CAL SHOULD DE INCLEASED DY 1 /0.   |
| 0x0D          | CAL_I5 | 16384   |  |



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### Flash Programming

Operational or test code can be programmed into the flash memory using either an in-circuit emulator or the Flash Download Board Module (FDBM) available from TERIDIAN. The flash programming procedure uses the E\_RTS, E\_RXTX, and E\_TCLK pins.

#### **MPU Firmware Library**

All application-specific MPU functions mentioned above under "Application Information" are available from TERIDIAN as a standard ANSI C library and as ANSI "C" source code. The code is available as part of the Demonstration Kit for the 71M6403. The Demonstration Kits come with the 71M6403 IC preprogrammed with demo firmware mounted on a functional example of a circuit breaker PCB (Demo Board). The Demo Boards allow for quick and efficient evaluation of the IC without having to write firmware or having to supply an in-circuit emulator (ICE).

A reference guide for firmware development on the 71M6403 is available as a separate document (Software User's Guide, "SUG"). The User's Manual supplied with the Demo Kit contains MPU address maps for the demo code as well as other useful information, such as sample calibration procedures.



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### **SPECIFICATIONS**

**Electrical Specifications** 

#### **ABSOLUTE MAXIMUM RATINGS**

| Supplies and Ground Pins:   |                                     |
|---|-------------------------------------|
| V3P3D, V3P3A  | -0.5V to 4.6V                       |
| V3P3D - V3P3A   | 0V to 0.5V                          |
| VLCD  | -0.5V to 7V                         |
| GNDD  | -0.5V to +0.5V                      |
| Analog Output Pins:   |                                     |
| VREF, VBIAS   | -1mA to 1mA,<br>-0.5 to V3P3A+0.5V  |
| V2P5  | -1mA to 1mA,<br>-0.5V to 3.0V       |
| Analog Input Pins:  |                                     |
| 10, 11, 12, 13, 14, 15, V2, INEUTRAL                                  | -0.5V to V3P3A+0.5V                 |
| CK38  | -0.5V to 3.0V                       |
| RX  | -0.5V to 3.6V                       |
| OPT_RX  | -1mA to 1mA<br>-0.5 to V3P3A+0.5V   |
| Digital Input Pins:   |                                     |
| DIO0-21, E_RXTX, E_RST, E_ISYNC/BRKRQ                                 | -0.5 to 6V                          |
| RESETZ  | -0.5 to V3P3D+0.5V                  |
| All Other Pins:   |                                     |
| Input pins  | -5mA to 5mA<br>-0.5V to V3P3D+0.5V  |
| Output pins   | -30mA to 30mA<br>-0.5 to V3P3D+0.5V |
| Temperature:  |                                     |
| Operating junction temperature (peak, 100ms)                          | 140 °C                              |
| Operating junction temperature (continuous)                           | 125 °C                              |
| Storage temperature   | –45 °C to 165 °C                    |
| Solder temperature – 10 second duration                               | 250 °C                              |
| ESD Stress:   |                                     |
| Pins I0, I1, I2, I3, I4, I5, RX, TX, E_RST, E_TCLK, E_RXTX, E_TBUS[n] | 4kV                                 |
| All other pins  | 2kV                                 |

Stresses beyond Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltages are with respect to GNDA.



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### **RECOMMENDED OPERATING CONDITIONS**

| PARAMETER             | CONDITION        | MIN | ТҮР | MAX  | UNIT |
|-----------------------|------------------|-----|-----|------|------|
| 3.3V Supply Voltage   | Normal Operation | 3.0 | 3.3 | 3.6  | V    |
| (V3P3A, V3P3D)        | Battery Backup   | 0   |     | 3.45 | V    |
| VLCD                  |                  | 2.9 |     | 5.5  | V    |
| Operating Temperature |                  | -40 |     | 85   | °C   |

<sup>†</sup>V3P3A and V3P3D should be shorted together on the circuit board. GNDA and GNDD should also be shorted on the circuit board.

### LOGIC LEVELS

| PARAMETER  | CONDITION                | MIN           | TYP | MAX   | UNIT |
|--|--------------------------|---------------|-----|-------|------|
| Digital high-level input voltage, $V_{IH}$                             |                          | 2             |     | V3P3D | V    |
| Digital low-level input voltage, V <sub>IL</sub>                       |                          | -0.3          |     | 0.8   | V    |
| Digital high lovel output voltage \/                                   | I <sub>LOAD</sub> = 1mA  | V3P3D<br>-0.4 |     | V3P3D | V    |
| Digital high-level output voltage $V_{\text{OH}}$                      | I <sub>LOAD</sub> = 15mA | V3P3D-<br>0.6 |     |       | V    |
| Digital low-level output voltage V <sub>OL</sub>                       | I <sub>LOAD</sub> = 1mA  | 0             |     | 0.4   | V    |
|  | I <sub>LOAD</sub> = 15mA |               |     | 0.8   | V    |
| Input pull-up current, II∟<br>RESETZ<br>E_RXTX, E_ISYNC/BRKRQ<br>E_RST | VIN=0V                   | 10            |     | 100   | μΑ   |
| Input pull down current, Iн<br>CK                                      | VIN=V3P3D                | 10            |     | 100   | μΑ   |
| Input current<br>Other digital inputs                                  |                          | -1            |     | 1     | μΑ   |



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#### SUPPLY CURRENT

| PARAMETER                    | CONDITION   | MIN | TYP | MAX | UNIT |
|------------------------------|---|-----|-----|-----|------|
| V3P3A + V3P3D + VLCD current | Normal Operation,   |     | 8.4 | 9.6 | mA   |
| V3P3A current                | V3P3A=V3P3D=VLCD=3.3V   |     | 4.4 | 4.9 | mA   |
| V3P3D current                | No Flash memory write<br>VBAT = 3.3V<br>RTM_EN = 0  |     | 3.7 | 4.2 | mA   |
| VLCD current                 | ECK_DIS = 1<br>MPU_DIV = 3  |     | 0.2 | 0.4 | mA   |
| V3P3A + V3P3D current        | Power save/sleep mode<br><b>V3P3A=V3P3D=VLCD</b> =3.3V<br>ADC_DIS = 1<br>CE_EN = 0<br>MPU_DIV = 3 |     | 6   | 7   | mA   |
| V3P3D current, Write Flash   | Normal Operation as above,<br>except write Flash at maximum<br>rate.                              |     | 7   |     | mA   |

### 2.5V VOLTAGE REGULATOR

Unless otherwise specified, load = 5mA

| PARAMETER                  | CONDITION                             | MIN | TYP | MAX | UNIT |
|----------------------------|---------------------------------------|-----|-----|-----|------|
| Voltage overhead V3P3-V2P5 | Reduce V3P3 until V2P5<br>drops 200mV |     |     | 440 | mV   |
| PSSR <b>AV2P5/AV3P3</b>    | RESETZ=1, iload=0                     | -3  |     | +3  | mV/V |



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### VREF, VBIAS

Unless otherwise specified, VREF\_DIS=0

| PARAMETER   | CONDITION   | MIN            | TYP             | MAX            | UNIT   |
|---|---|----------------|-----------------|----------------|--------|
| VREF output voltage, VNOM(25)   | Ta = 22°C   | 1.193          | 1.195           | 1.197          | V      |
| VREF chop step  |   |                |                 | 40             | mV     |
| VREF output impedance   | <i>CAL</i> =1,<br>Ι <sub>LOAD</sub> = 10μΑ, -10μΑ |                |                 | 2.5            | kΩ     |
| <b>VNOM</b> definition <sup>1</sup>   | VNOM(T) = VREF(22) + (T-                          | -22)TC1 + (    | 2               | V              |        |
| VREF temperature coefficients<br>TC1 (linear)<br>TC2 (quadratic)                                |   |                | μV/⁰C<br>μV/°C² |                |        |
| $\frac{VREF(T) \text{ deviation from VNOM(T)}}{VREF(T) - VNOM(T)} \frac{10^6}{\max( T-22 ,40)}$ | Ta = -40°C to +85°C                               | -40            |                 | +40            | ppm/°C |
| VBIAS output voltage  | Ta = 25°C<br>Ta = -40°C to 85°C                   | (-1%)<br>(-2%) | 1.6<br>1.6      | (+1%)<br>(+2%) | V<br>V |
| VBIAS output impedance  | Iload = 1mA, -1mA                                 |                | 240             | 500            | Ω      |

### FOOTNOTE

<sup>1</sup> This relationship describes the nominal behavior of VREF at different temperatures.



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### ADC CONVERTER, VDD REFERENCED

FIR\_LEN=0, VREF\_DIS=0, VDDREFZ=0

| PARAMETER   | CONDITION   | MIN  | TYP             | MAX        | UNIT       |
|---|---|------|-----------------|------------|------------|
| Recommended Input Range<br>(Vin- <b>V3P3A</b> )   |   | -250 |                 | 250        | mV<br>peak |
| THD (First 10 harmonics)<br>250mV-pk<br>20mV-pk   | Vin=65Hz,<br>64kpts FFT, Blackman-<br>Harris window |      |                 | -75<br>-90 | dB<br>dB   |
| Input Impedance   | Vin=65Hz  | 40   |                 | 90         | kΩ         |
| Temperature coefficient of Input<br>Impedance   | Vin=65Hz  |      | 1.7             |            | Ω/°C       |
| LSB size  |   |      | 355             |            | nV/LSB     |
| Digital Full Scale  |   |      | <u>+</u> 884736 |            | LSB        |
| ADC Gain Error vs<br>%Power Supply Variation<br>$\frac{10^{6} \Delta Nout_{PK} 357 nV / V_{IN}}{100 \Delta V 3P3A/3.3}$ | Vin=200mV pk, 65Hz<br>V3P3A=3.0v, 3.6V              |      |                 | 50         | ppm/%      |
| Input Offset (Vin- <b>V3P3A</b> )   |   | -10  |                 | 10         | mV         |

### **OPTICAL INTERFACE**

| PARAMETER  | CONDITION   | MIN | TYP | MAX | UNIT |
|--|-------------|-----|-----|-----|------|
| OPT_TX VOH (V3P3D-OPT_TX)                              | ISOURCE=1mA |     |     | 0.4 | V    |
| OPT_TX VOL   | ISINK=20mA  |     |     | 0.7 | V    |
| OPT_RX Vin Threshold<br>(VinRISING+VinFALLING)/2       |             | 200 | 250 | 300 | mV   |
| <b>OPT_RX</b> Vin Hysteresis<br>(VinRISING-VinFALLING) |             | 5   |     | 30  | mV   |
| <b>OPT_RX</b> input impedance                          | Vin ≤300mV  | 1   |     |     | MΩ   |

### **TEMPERATURE SENSOR**

| PARAMETER   | CONDITION   | MIN | TYP    | MAX | UNIT   |
|---|---|-----|--------|-----|--------|
| Nominal Sensitivity (S <sub>n</sub> ) <sup>2</sup>                              | TA=25°C, TA=75°C  |     | -900   |     | LSB/ºC |
| Nominal Offset (N <sub>n</sub> ) <sup>2</sup>                                   | Nominal relationship:<br>N(T)= S <sub>n</sub> *T+N <sub>n</sub> |     | 400000 |     | LSB    |
| Temperature Error <sup>3</sup><br>$ERR = (T - 25) - \frac{(N(T) - N(25))}{S_n}$ | TA = -40°C to +85°C   | -3  |        | 3   | °C     |

### FOOTNOTES

This parameter defines a nominal relationship rather than a measured parameter. Correct circuit operation is verified with other specs that use this nominal relationship as a reference. <sup>31</sup> This parameter is has been verified in production samples, but is not measured in production.



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### LCD BOOST

| PARAMETER           | CONDITION  | MIN | TYP       | MAX | UNIT |
|---------------------|--|-----|-----------|-----|------|
| VDRV Frequency      |  |     | CK / 1200 |     | Hz   |
| VDRV Sink Current   | Vol=1.5V   | 1.6 |           | 3.0 | mA   |
| VDRV Source Current | Voh=1.5V   | 1.2 |           | 2.6 | mA   |
| VLCD Target Voltage |  | 4.5 |           | 5.7 | V    |
| VLCD Input Current  | VLCD=5.0V, LCD_FS=1F,<br>LCD_MODE=0,1,2,3<br><i>LCD_BSTEN</i> =1 |     |           | 450 | μA   |

### LCD DRIVERS

Applies to all COM and SEG pins. Unless otherwise stated, VLCD=5.0V, LCD\_FS=1F

| PARAMETER                           | CONDITION  | MIN        | TYP | MAX        | UNIT   |
|-------------------------------------|--|------------|-----|------------|--------|
| VLC0 Max Voltage (LCD_FS =1F)       | With respect to VLCD                               | -0.2       |     | 0          | V      |
| VLC0 Min Voltage (LCD_FS =00)       | With respect to VLCD*0.7                           | -0.2       |     | 0.2        | V      |
| VLC1 Voltage,<br>1/3 bias<br>½ bias | With respect to 2*VLCD/3<br>With respect to VLCD/2 | -10<br>-10 |     | +10<br>+10 | %<br>% |
| VLC0 Voltage,<br>1/3 bias<br>½ bias | With respect to VLCD/3<br>With respect to VLCD/2   | -15<br>-10 |     | +15<br>+10 | %<br>% |
| Output Impedance                    | ΔILOAD=10μA  |            |     | 30         | kΩ     |

### RESETZ

| PARAMETER             | CONDITION | MIN | TYP | MAX | UNIT |
|-----------------------|-----------|-----|-----|-----|------|
| Reset pulse width     |           | 5   |     |     | μs   |
| Reset pulse fall time |           |     |     | 1   | μs   |

#### COMPARATORS

| PARAMETER                                    | CONDITION                | MIN        | TYP | MAX        | UNIT     |
|--|--------------------------|------------|-----|------------|----------|
| Offset Voltage<br>V2-VBIAS<br>INEUTRAL-VBIAS |                          | -20<br>-20 |     | 15<br>15   | mV<br>mV |
| Hysteresis Current<br>V2<br>INEUTRAL         | Vin = VBIAS - 100mV      | 0.8<br>0.8 |     | 1.2<br>1.2 | μA<br>μA |
| Response Time<br>V2<br>INEUTRAL              | <u>+</u> 100mV overdrive | 0.5<br>0.5 |     | 50<br>50   | μs<br>μs |



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### RAM AND FLASH MEMORY

| PARAMETER            | CONDITION      | MIN    | TYP | MAX | UNIT   |
|----------------------|----------------|--------|-----|-----|--------|
| CE RAM wait states   | CKMPU = 4.9MHz | 5      |     |     | Cycles |
| Flash write cycles   |                | 20,000 |     |     | Cycles |
| Flash data retention | 25°C           | 100    |     |     | Years  |

### FLASH MEMORY TIMING

| PARAMETER                 | CONDITION | MIN | TYP | MAX | UNIT |
|---------------------------|-----------|-----|-----|-----|------|
| Write Time per Byte       |           |     | 42  |     | μs   |
| Read Time: No wait states |           |     |     |     |      |
| Page Erase (512 bytes)    |           |     | 20  |     | ms   |
| Mass Erase                |           |     | 200 |     | ms   |

#### EEPROM INTERFACE

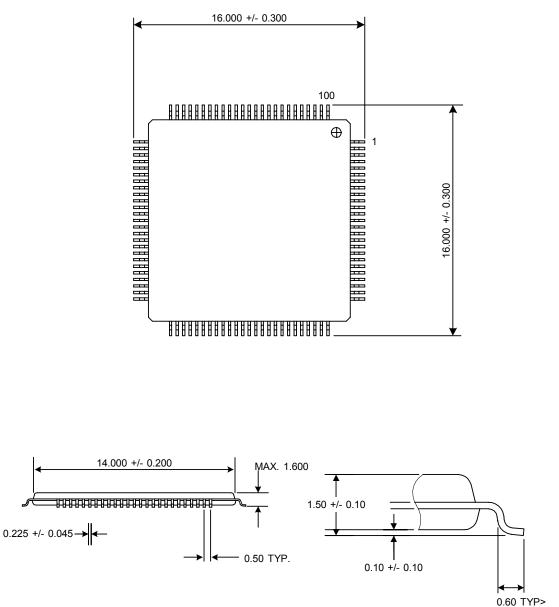
| PARAMETER             | CONDITION                             | MIN | TYP | MAX | UNIT |
|-----------------------|---------------------------------------|-----|-----|-----|------|
| Write Clock frequency | CKMPU=4.9MHz,<br>Using interrupts     |     | 78  |     | kHz  |
|                       | CKMPU=4.9MHz,<br>"bit-banging" DIO4/5 |     | 150 |     | kHz  |



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Packaging Information

### 100-Pin LQFP PACKAGE OUTLINE (Bottom View)

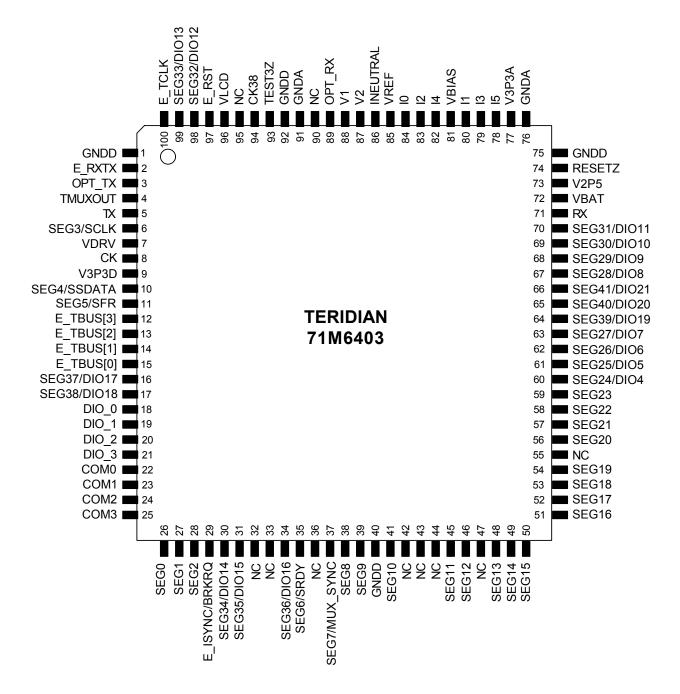


Side View



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### Pinout (Top View)





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### **Pin Descriptions**

#### **Power/Ground Pins**

| NAME  | PIN #                                 | TYPE | DESCRIPTION  |  |  |
|-------|---------------------------------------|------|--|--|--|
| GNDA  | 76,91                                 | Р    | Analog ground: This pin should be connected directly to the analog ground plane.<br>Recommend a common ground plane consisting of both GNDA and GNDD.    |  |  |
| GNDD  | 1, 40, 75, 92                         | Р    | Digital ground: This pin should be connected directly to the digital ground plane.<br>Recommend a common ground plane consisting of both GNDA and GNDD.  |  |  |
| V3P3A | 77                                    | Р    | Analog power supply: A 3.3V analog power supply should be connected to this pin.<br>Recommend a common power plane consisting of both V3P3A and V3P3D.   |  |  |
| V3P3D | 9                                     | Р    | Digital power supply: A 3.3V digital power supply should be connected to this pin.<br>Recommend a common power plane consisting of both V3P3A and V3P3D. |  |  |
| V2P5  | 73                                    | 0    | Output of the 2.5V regulator. A 0.1µF capacitor to GNDA should be connected to this pin.   |  |  |
| VBAT  | 72                                    | 0    | Battery backup power supply pin. A battery or super-capacitor may be connected between VBAT and GNDD. If no battery is used, connect VBAT to V3P3D.      |  |  |
| VLCD  | 96                                    | Р    | LCD power supply. The DC source for the LCD driver circuitry is connected here.  |  |  |
| NC    | 32,33,36,<br>42,43,44,<br>47,55,90,95 |      | No Connect   |  |  |

#### **Analog Pins**

| NAME                             | PIN #                            | TYPE | DESCRIPTION   |  |
|----------------------------------|----------------------------------|------|---|--|
| 10<br>11<br>12<br>13<br>14<br>15 | 84<br>80<br>83<br>79<br>82<br>78 | I    | Line Current Sense Inputs: These pins are voltage inputs to the internal A/D converter.<br>Typically, they are connected to the output of a current transformer.  |  |
| V1<br>V2<br>INEUTRAL             | 88<br>87<br>86                   | I    | Comparator Inputs - voltage inputs to the internal comparator: The voltages applied to these pins are compared to an internal BIAS voltage of 1.6V. If the input voltage is above VBIAS, the corresponding comparator output will be high (1). V1 is a status signal to the reset circuitry. It may also be used to disable the watchdog timer. Place a $0.1\mu$ F capacitor between pin V1 and GNDA. The V2 and INEUTRAL comparator outputs are maintained in <i>COMP_STAT</i> as follows: bit 1 = V2, bit 3 = INEUTRAL. A typical application is to sense the voltage on the DC supply. |  |
| VBIAS                            | 81                               | 0    | Reference voltage used by the power fault detection circuit.  |  |
| VREF                             | 85                               | I/O  | Voltage Reference for the ADC. A 0.1µF capacitor to GNDA should be connected to this pin.   |  |
| CK38                             | 94                               | I    | Low-frequency clock input. Provides time base for RTC, watchdog timer and ZP8.  |  |
| VDRV                             | 7                                | 0    | Voltage boost output.   |  |



| Digital Pins:                                    |                      |      |  |  |  |  |  |
|--|----------------------|------|--|--|--|--|--|
| NAME   | PIN #                | TYPE | DESCRIPTION  |  |  |  |  |
| DIO_3,<br>DIO_2,<br>DIO_1,<br>DIO_0              | 21<br>20<br>19<br>18 | I/O  | Digital input/output pins 0 through 3  |  |  |  |  |
| COM3,<br>COM2,<br>COM1,<br>COM0                  | 25<br>24<br>23<br>22 | 0    | LCD Common Outputs: These 4 pins provide the select signals for the LCD display.   |  |  |  |  |
| SEG0SEG2,<br>SEG8SEG23                           | See<br>pinout        | 0    | Dedicated LCD segment outputs  |  |  |  |  |
| SEG24/DIO4<br><br>SEG41/DIO21                    | See<br>pinout        | I/O  | Multi-use pins, configurable as either LCD SEG driver or DIO. (DIO4 = SCK, DIO5 = SDA when configured as EEPROM interface, STROBE = DIO6, FAULT_PULSE = DIO7 when configured as pulse outputs)   |  |  |  |  |
| SEG7/MUX_SYNC                                    | 37                   | 0    | Multi-use-pin LCD Segment Output/ MUX_SYNC is output for Synchronous serial interface  |  |  |  |  |
| SEG6/SRDY  | 35                   | I/O  | Multi-use-pin, LCD Segment Outputs/ SRDY input for Synchronous serial interface.   |  |  |  |  |
| SEG5/SFR   | 11                   | 0    | Multi-use-pin, LCD Segment Output/ SFR output for SSI.   |  |  |  |  |
| SEG4/SDATA                                       | 10                   | 0    | Multi-use-pin, LCD Segment Output/ SDATA output for SSI.   |  |  |  |  |
| SEG3/SCLK  | 6                    | 0    | Multi-use-pin, LCD Segment Output/ SCLK output for SSI.  |  |  |  |  |
| RESETZ   | 74                   | I    | Chip reset: This pin is used to reset the chip into a known state. For normal operation, this pin is set to 1. To reset the chip, this pin is driven to 0. This pin has an internal $30\mu$ A (nominal) current source pull-up but no Schmitt-trigger input circuitry. The minimum width of the pulse is $5\mu$ s. A $0.1\mu$ F capacitor to GNDA should be connected to this pin. |  |  |  |  |
| RX   | 71                   | 1    | UART input. The voltage applied at this input must be below 3.6V.  |  |  |  |  |
| ТХ   | 5                    | 0    | UART output.   |  |  |  |  |
| OPT_RX   | 89                   | I    | Optical Receive Input: This pin receives a signal from an external photo-detector used in an IR serial interface.  |  |  |  |  |
| OPT_TX   | 3                    | 0    | Optical LED Transmit Output: This pin is designed to directly drive an LED for transmitting data in an IR serial interface. Can be tristated with <i>OPT_TXDIS</i> to be multiplexed with other DIO pins.  |  |  |  |  |
| СК   | 8                    | 0    | Clock input (19.6608 MHz)  |  |  |  |  |
| TMUXOUT  | 4                    | 0    | Digital output test multiplexer. Controlled by DMUX[3:0].  |  |  |  |  |
| E_RXTX   | 2                    | I/O  | Emulator serial data.  |  |  |  |  |
| E_TBUS[3]<br>E_TBUS[2]<br>E_TBUS[1]<br>E_TBUS[0] | 12<br>13<br>14<br>15 | 0    | Emulator trace bus. These pins have internal pull-up resistors.  |  |  |  |  |
| E_ISYNC/BRKRQ                                    | 29                   | I/O  | Emulator handshake. This pin has an internal pull-up resistor.   |  |  |  |  |
| E_TCLK   | 100                  | 0    | Emulator clock. This pin has an internal pull-up resistor.   |  |  |  |  |
| E_RST  | 97                   | I    | Emulator reset. This pin has an internal pull-up resistor.   |  |  |  |  |
| TEST3  | 93                   | I    | For TERIDIAN internal use. This pin must be connected to GNDD via a $1k\Omega$ resistor.   |  |  |  |  |



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### **ORDERING INFORMATION**

| PART DESCRIPTION                                  | ORDERING<br>NUMBER | PACKAGE<br>MARKING |
|---|--------------------|--------------------|
| 71M6403   | 71M6403-IGT        | 71M6403-IGT        |
| Electronic Trip Unit, 100-pin LQFP                | 7 11010403-161     | XXXXXXXXXXXX       |
| 71M6403   | 71M6403-IGT/F      | 71M6403-IGT        |
| Electronic Trip Unit, 100-pin Lead-Free LQFP      | 7 11010403-1G1/F   | xxxxxxxxxF         |
| 71M6403   | 71M6403-IGTR       | 71M6403-IGT        |
| Electronic Trip Unit, 100-pin LQFP, T&R           | 7 11010403-1GTR    | xxxxxxxxxxx        |
| 71M6403   | 71M6403-IGTR/F     | 71M6403-IGT        |
| Electronic Trip Unit, 100-pin Lead-Free LQFP, T&R | 7 1100403-1GTR/F   | xxxxxxxxx          |

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